

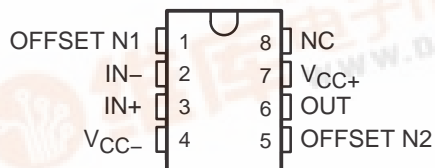
TL061, TL061A, TL061B, TL062, TL062A TL062B, TL064, TL064A, TL064B LOW-POWER JFET-INPUT OPERATIONAL AMPLIFIERS

SLOS078J – NOVEMBER 1978 – REVISED SEPTEMBER 2004

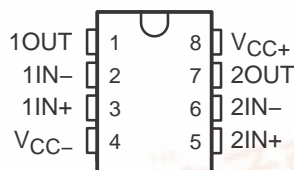
查询"81023012A"供应商

- Very Low Power Consumption
- Typical Supply Current . . . 200 μ A (Per Amplifier)
- Wide Common-Mode and Differential Voltage Ranges
- Low Input Bias and Offset Currents
- Common-Mode Input Voltage Range Includes V_{CC+}
- Output Short-Circuit Protection
- High Input Impedance . . . JFET-Input Stage
- Internal Frequency Compensation
- Latch-Up-Free Operation
- High Slew Rate . . . 3.5 V/ μ s Typ

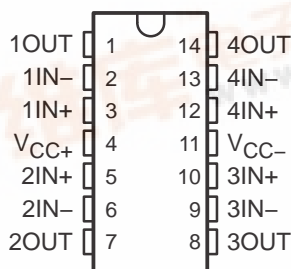
TL061, TL061A . . . D, P, OR PS PACKAGE
TL061B . . . P PACKAGE
(TOP VIEW)



TL062 . . . D, JG, P, PS, OR PW PACKAGE
TL062A . . . D, P, OR PS PACKAGE
TL062B . . . D OR P PACKAGE
(TOP VIEW)

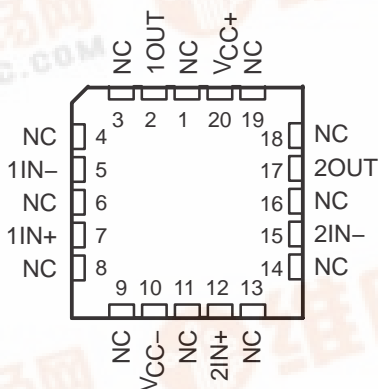


TL064 . . . D, J, N, NS, PW, OR W PACKAGE
TL064A, TL064B . . . D OR N PACKAGE
(TOP VIEW)

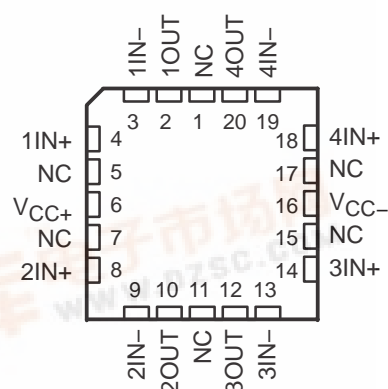


NC – No internal connection

TL062 . . . FK PACKAGE
(TOP VIEW)



TL064 . . . FK PACKAGE
(TOP VIEW)



description/ordering information

The JFET-input operational amplifiers of the TL06_ series are designed as low-power versions of the TL08_ series amplifiers. They feature high input impedance, wide bandwidth, high slew rate, and low input offset and input bias currents. The TL06_ series features the same terminal assignments as the TL07_ and TL08_ series. Each of these JFET-input operational amplifiers incorporates well-matched, high-voltage JFET and bipolar transistors in an integrated circuit.

The C-suffix devices are characterized for operation from 0°C to 70°C. The I-suffix devices are characterized for operation from -40°C to 85°C, and the M-suffix devices are characterized for operation over the full military temperature range of -55°C to 125°C.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.

**TEXAS
INSTRUMENTS**

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On products compliant to MIL-PRF-38535, all parameters are tested unless otherwise noted. On all other products, production processing does not necessarily include testing of all parameters.



**TL061, TL061A, TL061B, TL062, TL062A
 TL062B, TL064, TL064A, TL064B
 LOW-POWER JFET-INPUT OPERATIONAL AMPLIFIERS**

SLOAN 9102012A 11/15/04 SEPTEMBER 2004

description/ordering information (continued)

ORDERING INFORMATION

| TA | V _{IO} MAX AT 25°C | PACKAGE† | | ORDERABLE PART NUMBER | TOP-SIDE MARKING | |
|-------------|--------------------------------|------------|--------------|--------------------------|---------------------|----------|
| 0°C to 70°C | 15 mV | PDIP (P) | Tube of 50 | TL061CP | TL061CP | |
| | | | | TL062CP | TL062CP | |
| | | PDIP (N) | Tube of 25 | TL064CN | TL064CN | |
| | | SOIC (D) | Tube of 75 | TL061CD | TL061C | |
| | | | | TL061CDR | | |
| | | | Tube of 75 | TL062CD | TL062C | |
| | | | | TL062CDR | | |
| | | | Tube of 50 | TL064CD | TL064C | |
| | | | | TL064CDR | | |
| | | SOP (PS) | Reel of 2000 | TL061CPSR | T061 | |
| | | | | TL062CPSR | T062 | |
| | | SOP (NS) | Reel of 2000 | TL064CNSR | TL064 | |
| | | TSSOP (PW) | Tube of 150 | TL062CPW | T062 | |
| | | | | TL062CPWR | | |
| | | | Tube of 90 | TL064CPW | T064 | |
| | TL064CPWR | | | | | |
| | 6 mV | PDIP (P) | Tube of 50 | TL061ACP | TL061ACP | |
| | | | | TL062ACP | TL062ACP | |
| | | PDIP (N) | Tube of 25 | TL064ACN | TL064ACN | |
| | | SOIC (D) | Tube of 75 | TL061ACD | 061AC | |
| | | | | TL061ACDR | | |
| | | | Tube of 75 | TL062ACD | 062AC | |
| | | | | TL062ACDR | | |
| | | | Tube of 50 | TL064ACD | TL064AC | |
| | | | | TL064ACDR | | |
| | | SOP (PS) | Reel of 2000 | TL061ACPSR | T061A | |
| | | | | TL062ACPSR | T062A | |
| | | 3 mV | PDIP (P) | Tube of 50 | TL061BCP | TL061BCP |
| | | | | | TL062BCP | TL062BCP |
| | | | PDIP (N) | Tube of 25 | TL064BCN | TL064BCN |
| SOIC (D) | | | Tube of 75 | TL062BCD | 062BC | |
| | TL062BCDR | | | | | |
| | Tube of 50 | | TL064BCD | TL064BC | | |
| | | | TL064BCDR | | | |

† Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.



**TL061, TL061A, TL061B, TL062, TL062A
TL062B, TL064, TL064A, TL064B
LOW-POWER JFET-INPUT OPERATIONAL AMPLIFIERS**

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description/ordering information (continued)

ORDERING INFORMATION (continued)

| TA | V _{IO} MAX AT 25°C | PACKAGE† | | ORDERABLE PART NUMBER | TOP-SIDE MARKING |
|----------------|--------------------------------|------------|--------------|--------------------------|---------------------|
| -40°C to 85°C | 6 mV | PDIP (P) | Tube of 50 | TL061IP | TL061IP |
| | | | | TL062IP | TL062IP |
| | | PDIP (N) | Tube of 25 | TL064IN | TL064IN |
| | | SOIC (D) | Tube of 75 | TL061ID | TL061I |
| | | | | TL061IDR | |
| | | | Tube of 75 | TL062ID | TL062I |
| | | | | TL062IDR | |
| | | | Tube of 50 | TL064ID | TL064I |
| | | | | TL064IDR | |
| | | TSSOP (PW) | Reel of 2000 | TL062IPWR | TL062I |
| -55°C to 125°C | 6 mV | CDIP (JG) | Tube of 50 | TL062MJG | TL062MJG |
| | | LCCC (FK) | Tube of 55 | TL062MFK | TL062MFK |
| | 9 mV | CDIP (J) | Tube of 25 | TL064MJ | TL064MJ |
| | | CFP (W) | Tube of 150 | TL064MW | TL064MW |
| | | LCCC (FK) | Tube of 55 | TL064MFK | TL064MFK |

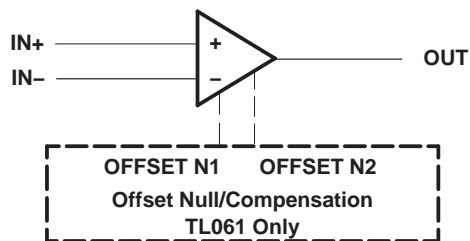
† Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.

TL061, TL061A, TL061B, TL062, TL062A TL062B, TL064, TL064A, TL064B LOW-POWER JFET-INPUT OPERATIONAL AMPLIFIERS

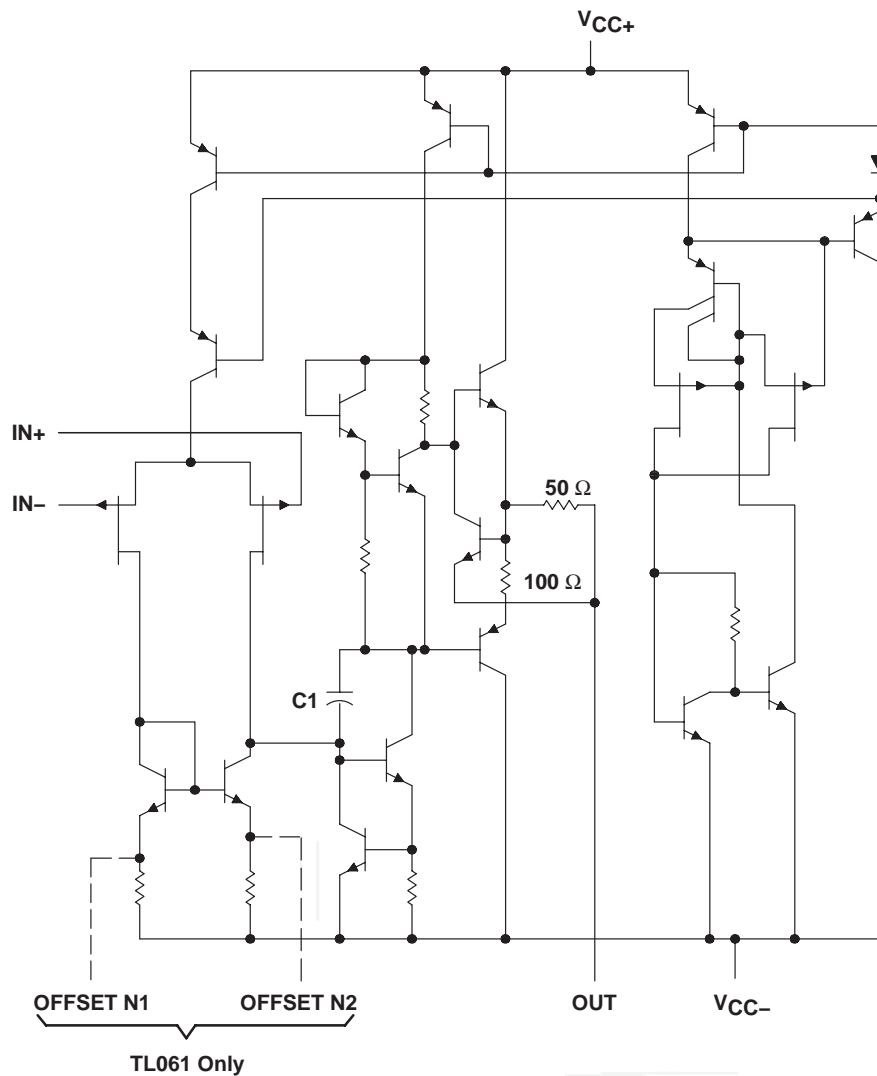
SLOS061 (REVISED) SEPTEMBER 2004

查看 TL061/2A 的应用

symbol (each amplifier)



schematic (each amplifier)



$C1 = 10 \text{ pF}$ on TL061, TL062, and TL064
Component values shown are nominal.

**TL061, TL061A, TL061B, TL062, TL062A
TL062B, TL064, TL064A, TL064B
LOW-POWER JFET-INPUT OPERATIONAL AMPLIFIERS**

SLOS078J – NOVEMBER 1978 – REVISED SEPTEMBER 2004

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absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

| | | TL06_C TL06_AC TL06_BC | TL06_I | TL06_M | UNIT |
|--|--------------------------------|------------------------------|------------|------------|------|
| Supply voltage, V_{CC+} (see Note 1) | | 18 | 18 | 18 | V |
| Supply voltage, V_{CC-} (see Note 1) | | -18 | -18 | -18 | V |
| Differential input voltage, V_{ID} (see Note 2) | | ± 30 | ± 30 | ± 30 | V |
| Input voltage, V_I (see Notes 1 and 3) | | ± 15 | ± 15 | ± 15 | V |
| Duration of output short circuit (see Note 4) | | Unlimited | Unlimited | Unlimited | |
| Package thermal impedance, θ_{JA} (see Notes 5 and 6) | D (8-pin) package | 97 | 97 | | °C/W |
| | D (14-pin) package | 86 | 86 | | |
| | N package | 80 | 80 | | |
| | NS package | 76 | 76 | | |
| | P package | 85 | 85 | | |
| | PS package | 95 | 95 | | |
| | PW (8-pin) package | 149 | 149 | | |
| Package thermal impedance, θ_{JC} (see Notes 7 and 8) | FK package | | | 5.61 | °C/W |
| | J package | | | 15.05 | |
| | JG package | | | 14.5 | |
| | W package | | | 14.65 | |
| Operating virtual junction temperature, T_J | | 150 | 150 | 150 | °C |
| Case temperature for 60 seconds | FK package | | | 260 | °C |
| Lead temperature 1,6 mm (1/16 inch) from case for 60 seconds | J, JG, U, or W package | | | 300 | °C |
| Lead temperature 1,6 mm (1/16 inch) from case for 10 seconds | D, N, NS, P, PS, or PW package | 260 | 260 | | °C |
| Storage temperature range, T_{stg} | | -65 to 150 | -65 to 150 | -65 to 150 | °C |

† Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES:
- All voltage values except differential voltages are with respect to the midpoint between V_{CC+} and V_{CC-} .
 - Differential voltages are at $IN+$ with respect to $IN-$.
 - The magnitude of the input voltage should never exceed the magnitude of the supply voltage or 15 V, whichever is less.
 - The output may be shorted to ground or to either supply. Temperature and/or supply voltages must be limited to ensure that the dissipation rating is not exceeded.
 - Maximum power dissipation is a function of $T_J(\max)$, θ_{JA} , and T_A . The maximum allowable power dissipation at any allowable ambient temperature is $P_D = (T_J(\max) - T_A)/\theta_{JA}$. Operating at the absolute maximum T_J of 150°C can affect reliability.
 - The package thermal impedance is calculated in accordance with JESD 51-7.
 - Maximum power dissipation is a function of $T_J(\max)$, θ_{JC} , and T_C . The maximum allowable power dissipation at any allowable case temperature is $P_D = (T_J(\max) - T_C)/\theta_{JC}$. Operating at the absolute maximum T_J of 150°C can affect reliability.
 - The package thermal impedance is calculated in accordance with MIL-STD-883.



TL061, TL061A, TL061B, TL062, TL062A TL062B, TL064, TL064A, TL064B LOW-POWER JFET-INPUT OPERATIONAL AMPLIFIERS

SLOS091C (REVISED) SEPTEMBER 2004

electrical characteristics, $V_{CC\pm} = \pm 15\text{ V}$ (unless otherwise noted)

| PARAMETER | TEST CONDITIONS† | TL061C TL062C TL064C | | | TL061AC TL062AC TL064AC | | | UNIT | | |
|-------------------|---|--|-----|---------------------------|-------------------------------|-----------------|--------------------------|-----------------|------------------------------|------|
| | | MIN | TYP | MAX | MIN | TYP | MAX | | | |
| V_{IO} | Input offset voltage | $V_O = 0,$ $R_S = 50\ \Omega$ | | $T_A = 25^\circ\text{C}$ | 3 | 15 | $T_A = 25^\circ\text{C}$ | 3 | 6 | mV |
| | | | | $T_A = \text{Full range}$ | 20 | | 7.5 | | | |
| $\alpha_{V_{IO}}$ | Temperature coefficient of input offset voltage | $V_O = 0, R_S = 50\ \Omega,$ $T_A = \text{Full range}$ | | | 10 | | 10 | | $\mu\text{V}/^\circ\text{C}$ | |
| I_{IO} | Input offset current | $V_O = 0$ | | $T_A = 25^\circ\text{C}$ | 5 | 200 | $T_A = 25^\circ\text{C}$ | 5 | 100 | pA |
| | | | | $T_A = \text{Full range}$ | 5 | | 3 | | nA | |
| I_{IB} | Input bias current‡ | $V_O = 0$ | | $T_A = 25^\circ\text{C}$ | 30 | 400 | $T_A = 25^\circ\text{C}$ | 30 | 200 | pA |
| | | | | $T_A = \text{Full range}$ | 10 | | 7 | | nA | |
| V_{ICR} | Common-mode input voltage range | $T_A = 25^\circ\text{C}$ | | | ± 11 | -12 to 15 | ± 11 | -12 to 15 | V | |
| V_{OM} | Maximum peak output voltage swing | $R_L = 10\ \text{k}\Omega,$ | | $T_A = 25^\circ\text{C}$ | ± 10 | ± 13.5 | ± 10 | ± 13.5 | V | |
| | | $R_L \geq 10\ \text{k}\Omega,$ | | $T_A = \text{Full range}$ | ± 10 | | ± 10 | | | |
| A_{VD} | Large-signal differential voltage amplification | $V_O = \pm 10\ \text{V},$ $R_L \geq 10\ \text{k}\Omega$ | | $T_A = 25^\circ\text{C}$ | 3 | 6 | $T_A = 25^\circ\text{C}$ | 4 | 6 | V/mV |
| | | | | $T_A = \text{Full range}$ | 3 | | 4 | | | |
| B_1 | Unity-gain bandwidth | $R_L = 10\ \text{k}\Omega,$ | | $T_A = 25^\circ\text{C}$ | 1 | | 1 | | MHz | |
| r_i | Input resistance | $T_A = 25^\circ\text{C}$ | | | 10^{12} | | 10^{12} | | Ω | |
| CMRR | Common-mode rejection ratio | $V_{IC} = V_{ICRmin}, V_O = 0,$ $R_S = 50\ \Omega, T_A = 25^\circ\text{C}$ | | | 70 | 86 | 80 | 86 | dB | |
| k_{SVR} | Supply-voltage rejection ratio ($\Delta V_{CC\pm}/\Delta V_{IO}$) | $V_{CC} = \pm 9\ \text{V to } \pm 15\ \text{V},$ $V_O = 0, R_S = 50\ \Omega,$ $T_A = 25^\circ\text{C}$ | | | 70 | 95 | 80 | 95 | dB | |
| P_D | Total power dissipation (each amplifier) | $V_O = 0,$ No load | | $T_A = 25^\circ\text{C},$ | 6 | 7.5 | 6 | 7.5 | mW | |
| I_{CC} | Supply current (each amplifier) | $V_O = 0,$ No load | | $T_A = 25^\circ\text{C},$ | 200 | 250 | 200 | 250 | μA | |
| V_{O1}/V_{O2} | Crosstalk attenuation | $A_{VD} = 100,$ | | $T_A = 25^\circ\text{C}$ | 120 | | 120 | | dB | |

† All characteristics are measured under open-loop conditions with zero common-mode input voltage unless otherwise specified. Full range for T_A is 0°C to 70°C for TL06_C, TL06_AC, and TL06_BC and -40°C to 85°C for TL06_I.

‡ Input bias currents of an FET-input operational amplifier are normal junction reverse currents, which are temperature sensitive, as shown in Figure 15. Pulse techniques are used to maintain the junction temperature as close to the ambient temperature as possible.

electrical characteristics, $V_{CC\pm} = \pm 15\text{ V}$ (unless otherwise noted)

| PARAMETER | TEST CONDITIONS† | TL061BC TL062BC TL064BC | | | TL061I TL062I TL064I | | | UNIT |
|---|--|-------------------------------|------------|----------|----------------------------|---------------------------|-----|------------------------------|
| | | MIN | TYP | MAX | MIN | TYP | MAX | |
| V_{IO} Input offset voltage | $V_O = 0$, $R_S = 50\ \Omega$ | $T_A = 25^\circ\text{C}$ | | 2 | 3 | $T_A = 25^\circ\text{C}$ | | mV |
| | | $T_A = \text{Full range}$ | | 5 | | $T_A = \text{Full range}$ | | |
| $\alpha_{V_{IO}}$ Temperature coefficient of input offset voltage | $V_O = 0$, $R_S = 50\ \Omega$, $T_A = \text{Full range}$ | 10 | | | 10 | | | $\mu\text{V}/^\circ\text{C}$ |
| I_{IO} Input offset current | $V_O = 0$ | $T_A = 25^\circ\text{C}$ | | 5 | 100 | $T_A = 25^\circ\text{C}$ | | pA |
| | | $T_A = \text{Full range}$ | | 3 | | $T_A = \text{Full range}$ | | 10 nA |
| I_{IB} Input bias current‡ | $V_O = 0$ | $T_A = 25^\circ\text{C}$ | | 30 | 200 | $T_A = 25^\circ\text{C}$ | | pA |
| | | $T_A = \text{Full range}$ | | 7 | | $T_A = \text{Full range}$ | | 20 nA |
| V_{ICR} Common-mode input voltage range | $T_A = 25^\circ\text{C}$ | ± 11 | -12 to 15 | ± 11 | -12 to 15 | | | V |
| V_{OM} Maximum peak output voltage swing | $R_L = 10\ \text{k}\Omega$, $T_A = 25^\circ\text{C}$ | ± 10 | ± 13.5 | ± 10 | ± 13.5 | | | V |
| | $R_L \geq 10\ \text{k}\Omega$, $T_A = \text{Full range}$ | ± 10 | | ± 10 | | | | |
| A_{VD} Large-signal differential voltage amplification | $V_O = \pm 10\ \text{V}$, $R_L \geq 10\ \text{k}\Omega$ | $T_A = 25^\circ\text{C}$ | | 4 | 6 | $T_A = 25^\circ\text{C}$ | | V/mV |
| | | $T_A = \text{Full range}$ | | 4 | | $T_A = \text{Full range}$ | | |
| B_1 Unity-gain bandwidth | $R_L = 10\ \text{k}\Omega$, $T_A = 25^\circ\text{C}$ | 1 | | | 1 | | | MHz |
| r_i Input resistance | $T_A = 25^\circ\text{C}$ | 10^{12} | | | 10^{12} | | | Ω |
| CMRR Common-mode rejection ratio | $V_{IC} = V_{ICRmin}$, $V_O = 0$, $R_S = 50\ \Omega$, $T_A = 25^\circ\text{C}$ | 80 | 86 | 80 | 86 | | | dB |
| k_{SVR} Supply-voltage rejection ratio ($\Delta V_{CC\pm}/\Delta V_{IO}$) | $V_{CC} = \pm 9\ \text{V}$ to $\pm 15\ \text{V}$, $V_O = 0$, $R_S = 50\ \Omega$, $T_A = 25^\circ\text{C}$ | 80 | 95 | 80 | 95 | | | dB |
| P_D Total power dissipation (each amplifier) | $V_O = 0$, No load | $T_A = 25^\circ\text{C}$ | | 6 | 7.5 | $T_A = 25^\circ\text{C}$ | | mW |
| I_{CC} Supply current (each amplifier) | $V_O = 0$, No load | $T_A = 25^\circ\text{C}$ | | 200 | 250 | $T_A = 25^\circ\text{C}$ | | μA |
| VO_1/VO_2 Crosstalk attenuation | $A_{VD} = 100$, $T_A = 25^\circ\text{C}$ | 120 | | | 120 | | | dB |

† All characteristics are measured under open-loop conditions with zero common-mode input voltage, unless otherwise specified. Full range for T_A is 0°C to 70°C for TL06_C, TL06_AC, and TL06_BC and -40°C to 85°C for TL06_I.

‡ Input bias currents of an FET-input operational amplifier are normal junction reverse currents, which are temperature sensitive, as shown in Figure 15. Pulse techniques are used to maintain the junction temperature as close to the ambient temperature as possible.

**TL061, TL061A, TL061B, TL062, TL062A
TL062B, TL064, TL064A, TL064B
LOW-POWER JFET-INPUT OPERATIONAL AMPLIFIERS**

SLOSH001C, NOVEMBER 2008 (REVISED) SEPTEMBER 2004

electrical characteristics, $V_{CC\pm} = \pm 15$ V (unless otherwise noted)

| PARAMETER | TEST CONDITIONS† | TL061M TL062M | | | TL064M | | | UNIT |
|---|---|---|------------|------------|------------|--------------------------|-----|------------------------------|
| | | MIN | TYP | MAX | MIN | TYP | MAX | |
| V_{IO} Input offset voltage | $V_O = 0$, $R_S = 50 \Omega$ | $T_A = 25^\circ\text{C}$ | | 3 | 6 | $T_A = 25^\circ\text{C}$ | | mV |
| | | $T_A = -55^\circ\text{C to } 125^\circ\text{C}$ | | 9 | | 15 | | |
| $\alpha_{V_{IO}}$ Temperature coefficient of input offset voltage | $V_O = 0$, $R_S = 50 \Omega$, $T_A = -55^\circ\text{C to } 125^\circ\text{C}$ | 10 | | | 10 | | | $\mu\text{V}/^\circ\text{C}$ |
| I_{IO} Input offset current | $V_O = 0$ | $T_A = 25^\circ\text{C}$ | | 5 | 100 | $T_A = 25^\circ\text{C}$ | | pA |
| | | $T_A = -55^\circ\text{C}$ | | 20* | | 20* | | nA |
| | | $T_A = 125^\circ\text{C}$ | | 20 | | 20 | | |
| I_{IB} Input bias current‡ | $V_O = 0$ | $T_A = 25^\circ\text{C}$ | | 30 | 200 | $T_A = 25^\circ\text{C}$ | | pA |
| | | $T_A = -55^\circ\text{C}$ | | 50* | | 50* | | nA |
| | | $T_A = 125^\circ\text{C}$ | | 50 | | 50 | | |
| V_{ICR} Common-mode input voltage range | $T_A = 25^\circ\text{C}$ | ± 11.5 | -12 to 15 | ± 11.5 | -12 to 15 | | | V |
| V_{OM} Maximum peak output voltage swing | $R_L = 10 \text{ k}\Omega$, $T_A = 25^\circ\text{C}$ | ± 10 | ± 13.5 | ± 10 | ± 13.5 | | | V |
| | $R_L \geq 10 \text{ k}\Omega$, $T_A = -55^\circ\text{C to } 125^\circ\text{C}$ | ± 10 | | ± 10 | | | | |
| A_{VD} Large-signal differential voltage amplification | $V_O = \pm 10 \text{ V}$, $R_L \geq 10 \text{ k}\Omega$ | $T_A = 25^\circ\text{C}$ | | 4 | 6 | $T_A = 25^\circ\text{C}$ | | V/mV |
| | | $T_A = -55^\circ\text{C to } 125^\circ\text{C}$ | | 4 | | 4 | | |
| B_1 Unity-gain bandwidth | $R_L = 10 \text{ k}\Omega$, $T_A = 25^\circ\text{C}$ | | | | | | | MHz |
| r_i Input resistance | $T_A = 25^\circ\text{C}$ | 10^{12} | | | 10^{12} | | | Ω |
| CMRR Common-mode rejection ratio | $V_{IC} = V_{ICRmin}$, $V_O = 0$, $R_S = 50 \Omega$, $T_A = 25^\circ\text{C}$ | 80 | 86 | 80 | 86 | | | dB |
| k_{SVR} Supply-voltage rejection ratio ($\Delta V_{CC\pm}/\Delta V_{IO}$) | $V_{CC} = \pm 9 \text{ V to } \pm 15 \text{ V}$, $V_O = 0$, $R_S = 50 \Omega$, $T_A = 25^\circ\text{C}$ | 80 | 95 | 80 | 95 | | | dB |
| P_D Total power dissipation (each amplifier) | $V_O = 0$, No load | $T_A = 25^\circ\text{C}$ | | 6 | 7.5 | $T_A = 25^\circ\text{C}$ | | mW |
| I_{CC} Supply current (each amplifier) | $V_O = 0$, No load | $T_A = 25^\circ\text{C}$ | | 200 | 250 | $T_A = 25^\circ\text{C}$ | | μA |
| V_{O1}/V_{O2} Crosstalk attenuation | $A_{VD} = 100$, $T_A = 25^\circ\text{C}$ | 120 | | | 120 | | | dB |

* This parameter is not production tested.

† All characteristics are measured under open-loop conditions, with zero common-mode voltage, unless otherwise specified.

‡ Input bias currents of an FET-input operational amplifier are normal junction reverse currents, which are temperature sensitive, as shown in Figure 15. Pulse techniques are used to maintain the junction temperature as close to the ambient temperature as possible.

operating characteristics, $V_{CC\pm} = \pm 15$ V, $T_A = 25^\circ\text{C}$

| PARAMETER | TEST CONDITIONS | MIN | TYP | MAX | UNIT |
|---|--|-----|-----|-----|------------------------|
| SR Slew rate at unity gain (see Note 5) | $V_I = 10 \text{ V}$, $R_L = 10 \text{ k}\Omega$, $C_L = 100 \text{ pF}$, See Figure 1 | 1.5 | 3.5 | | V/ μs |
| t_r Rise time | $V_I = 20 \text{ mV}$, $C_L = 100 \text{ pF}$, See Figure 1 | 0.2 | | | μs |
| Overshoot factor | | 10% | | | |
| V_n Equivalent input noise voltage | $R_S = 20 \Omega$, $f = 1 \text{ kHz}$ | 42 | | | nV/ $\sqrt{\text{Hz}}$ |

NOTE 5: Slew rate at $-55^\circ\text{C to } 125^\circ\text{C}$ is 0.7 V/ μs min.



PARAMETER MEASUREMENT INFORMATION

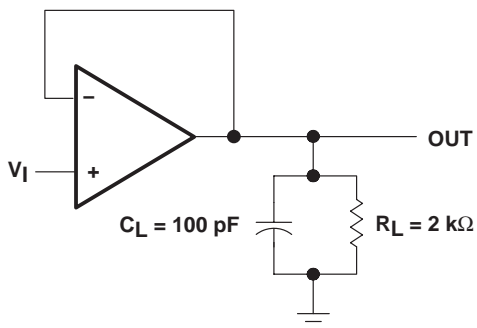


Figure 1. Unity-Gain Amplifier

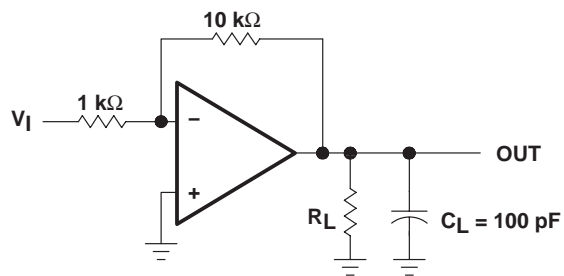


Figure 2. Gain-of-10 Inverting Amplifier

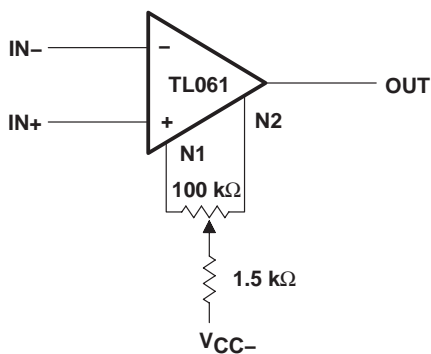


Figure 3. Input Offset-Voltage Null Circuit

**TL061, TL061A, TL061B, TL062, TL062A
 TL062B, TL064, TL064A, TL064B
 LOW-POWER JFET-INPUT OPERATIONAL AMPLIFIERS**

SLOAN VALLEY, CALIFORNIA 94588 SEPTEMBER 2004
 查特 TL061, TL062A 放大器

TYPICAL CHARACTERISTICS

Table of Graphs

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| Maximum peak output voltage vs Load resistance | 6 |
| Maximum peak output voltage vs Frequency | 7 |
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TYPICAL CHARACTERISTICS†

MAXIMUM PEAK OUTPUT VOLTAGE
vs
SUPPLY VOLTAGE

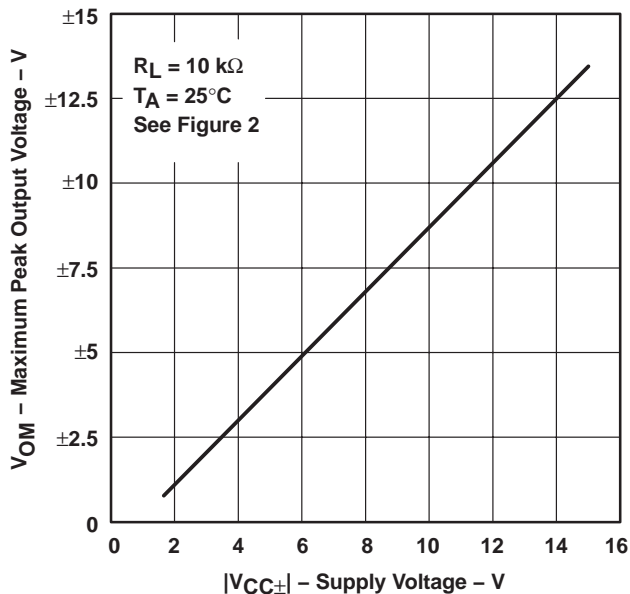


Figure 4

MAXIMUM PEAK OUTPUT VOLTAGE
vs
FREE-AIR TEMPERATURE

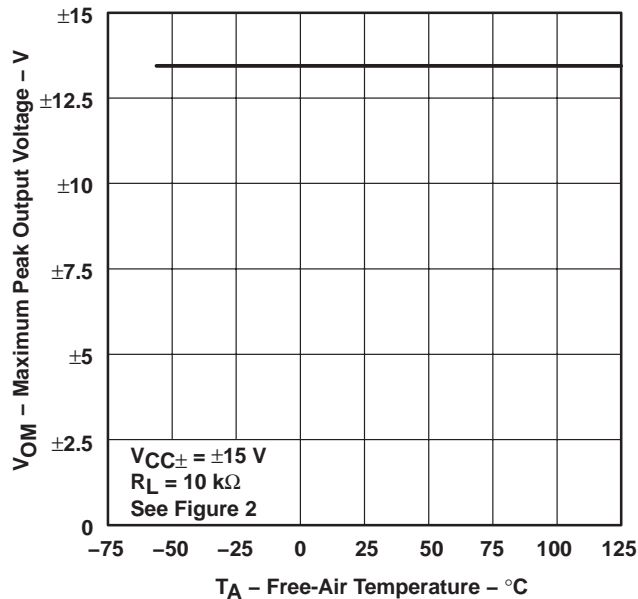


Figure 5

MAXIMUM PEAK OUTPUT VOLTAGE
vs
LOAD RESISTANCE

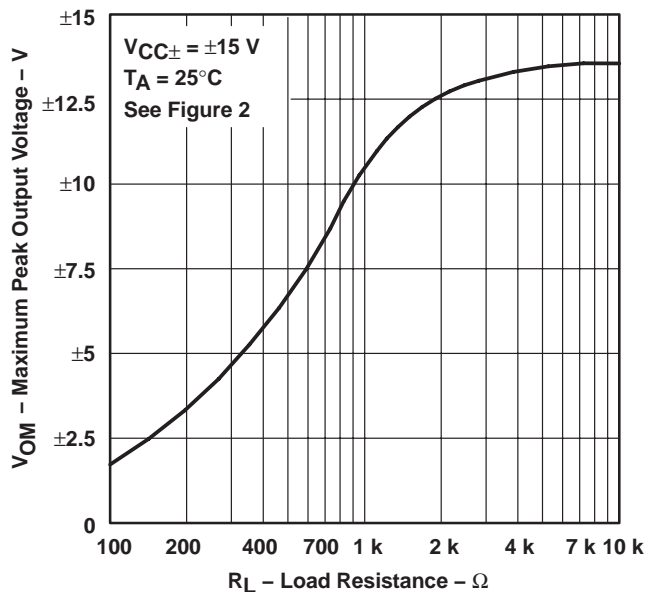


Figure 6

MAXIMUM PEAK OUTPUT VOLTAGE
vs
FREQUENCY

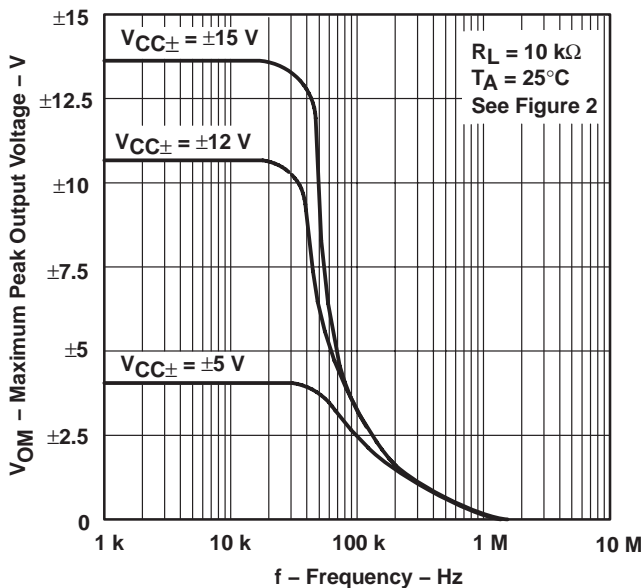


Figure 7

† Data at high and low temperatures are applicable only within the specified operating free-air temperature ranges of the various devices.

TL061, TL061A, TL061B, TL062, TL062A
 TL062B, TL064, TL064A, TL064B
 LOW-POWER JFET-INPUT OPERATIONAL AMPLIFIERS

SLOAN 9100010001 SEPTEMBER 1978 (REVISED) SEPTEMBER 2004

TYPICAL CHARACTERISTICS†

DIFFERENTIAL VOLTAGE AMPLIFICATION
 vs
 FREE-AIR TEMPERATURE

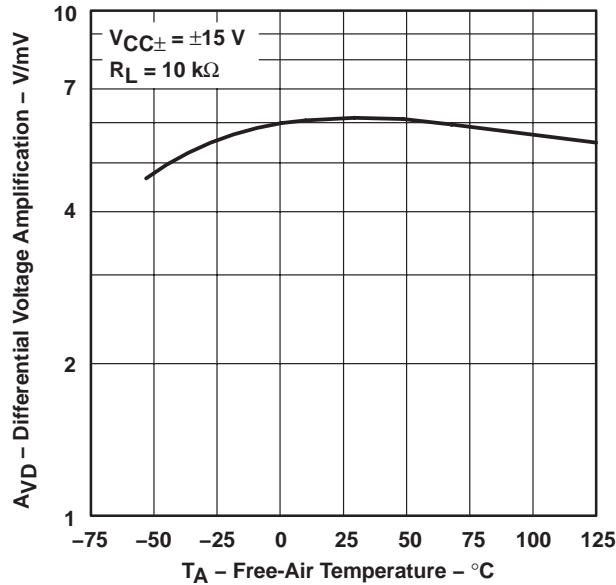


Figure 8

LARGE-SIGNAL
 DIFFERENTIAL VOLTAGE
 AMPLIFICATION AND PHASE SHIFT
 vs
 FREQUENCY

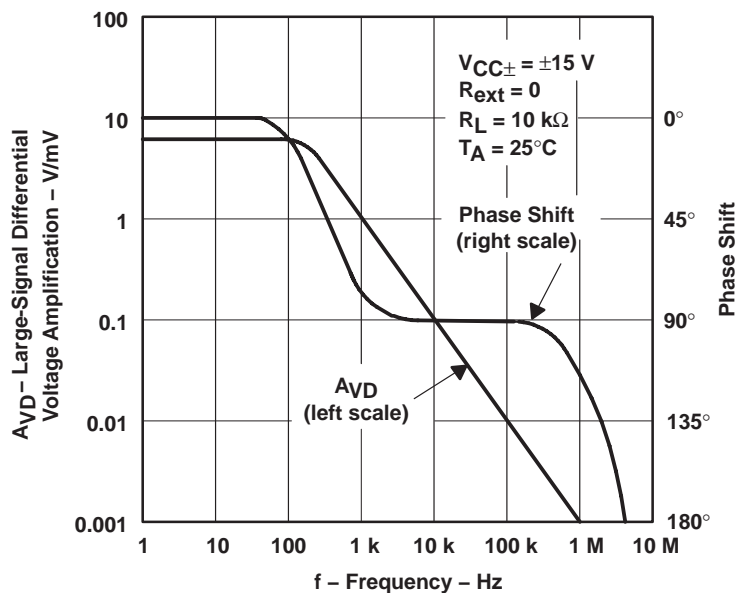


Figure 9

† Data at high and low temperatures are applicable only within the specified operating free-air temperature ranges of the various devices.



TYPICAL CHARACTERISTICS†

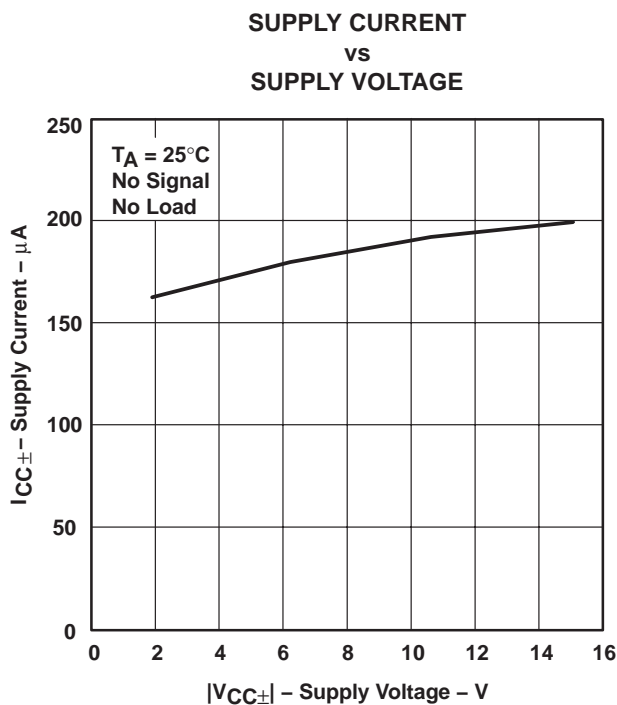


Figure 10

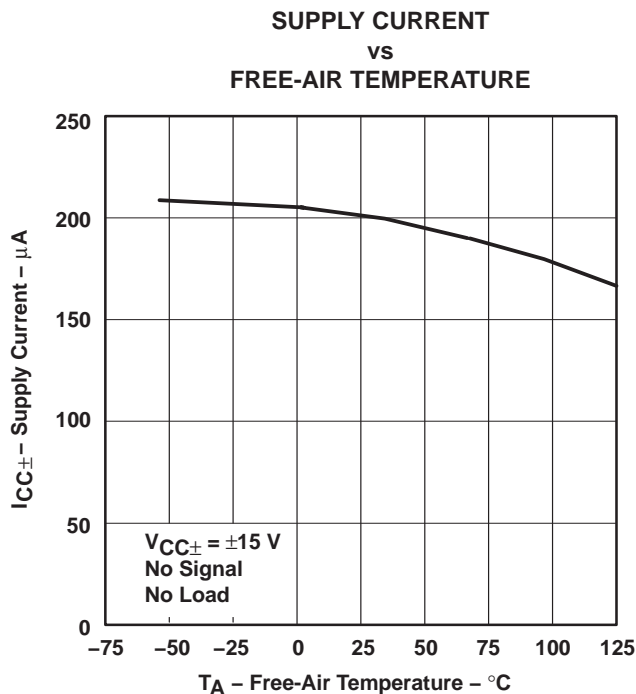


Figure 11

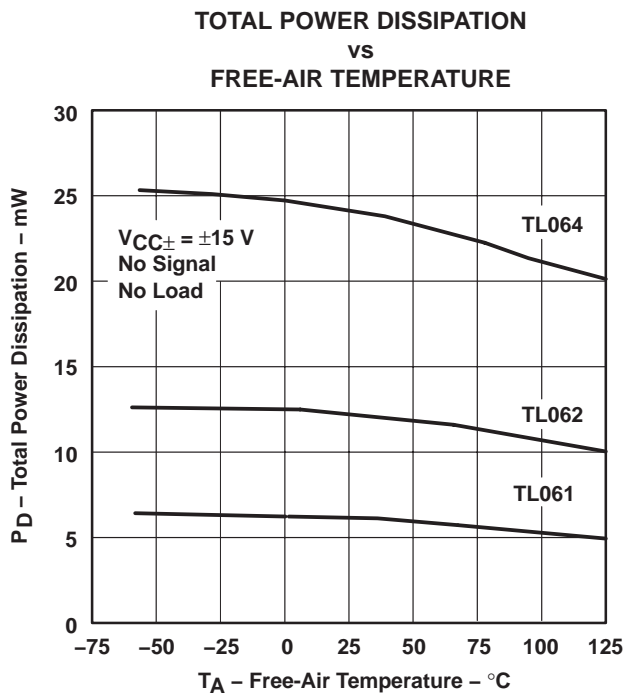


Figure 12

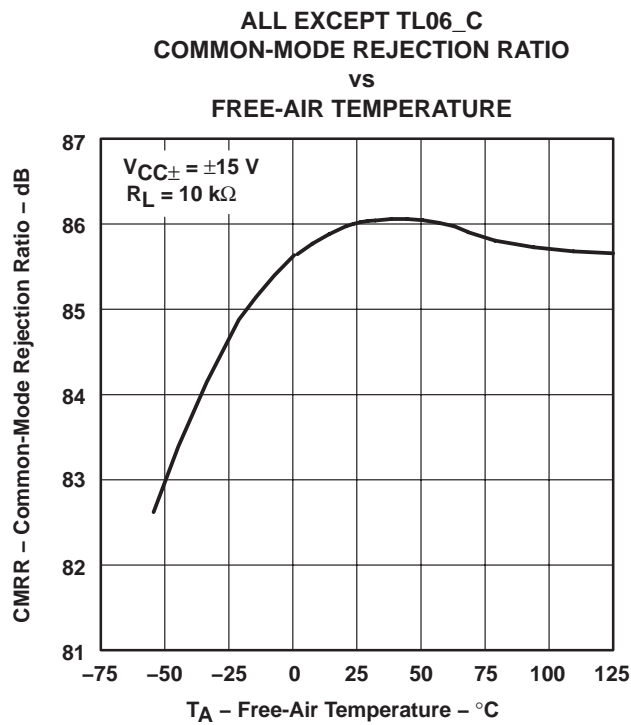


Figure 13

† Data at high and low temperatures are applicable only within the specified operating free-air temperature ranges of the various devices.

**TL061, TL061A, TL061B, TL062, TL062A
 TL062B, TL064, TL064A, TL064B
 LOW-POWER JFET-INPUT OPERATIONAL AMPLIFIERS**

SLOAN 910001001298 11/5/98 SEPTEMBER 2004

TYPICAL CHARACTERISTICS

**NORMALIZED UNITY-GAIN BANDWIDTH,
 SLEW RATE, AND PHASE SHIFT**

vs

FREE-AIR TEMPERATURE

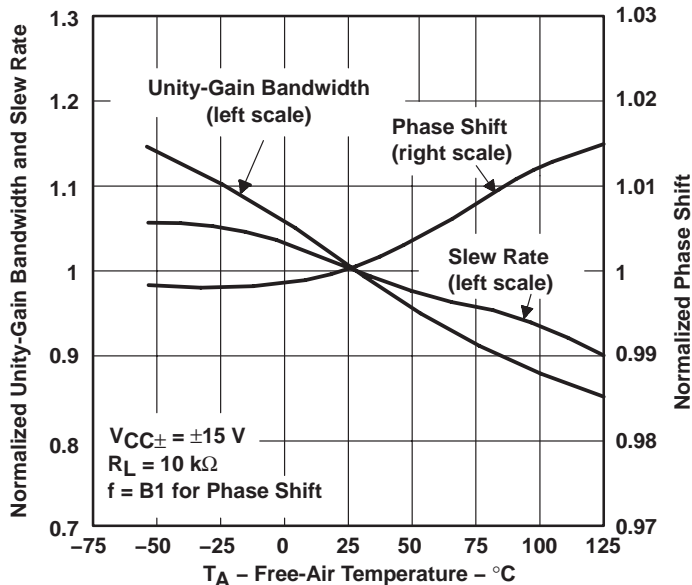


Figure 14

**INPUT BIAS CURRENT
 vs
 FREE-AIR TEMPERATURE**

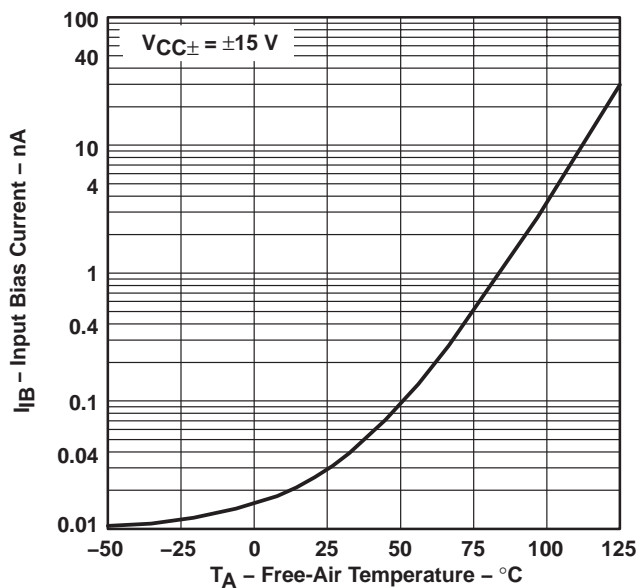


Figure 15

**VOLTAGE-FOLLOWER
 LARGE-SIGNAL PULSE RESPONSE
 vs
 TIME**

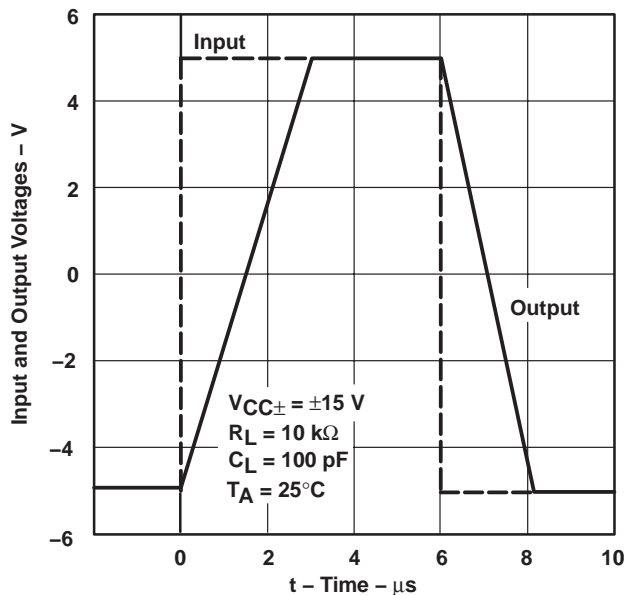
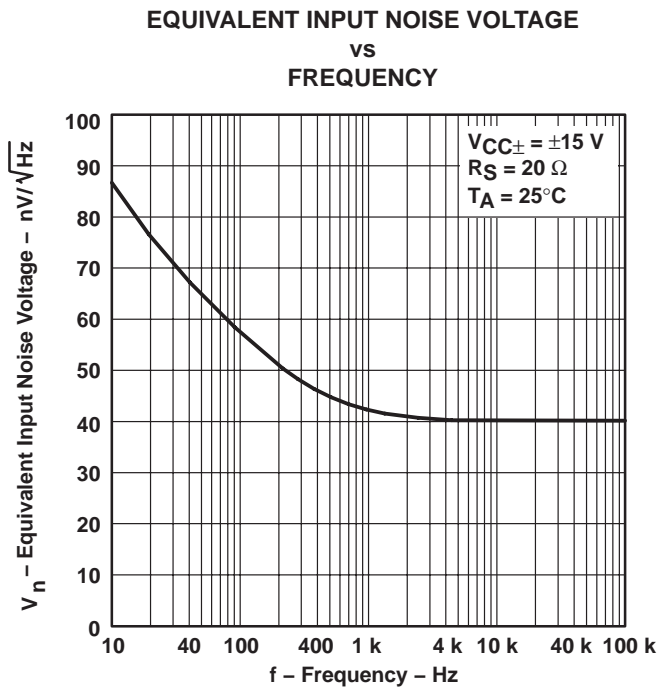
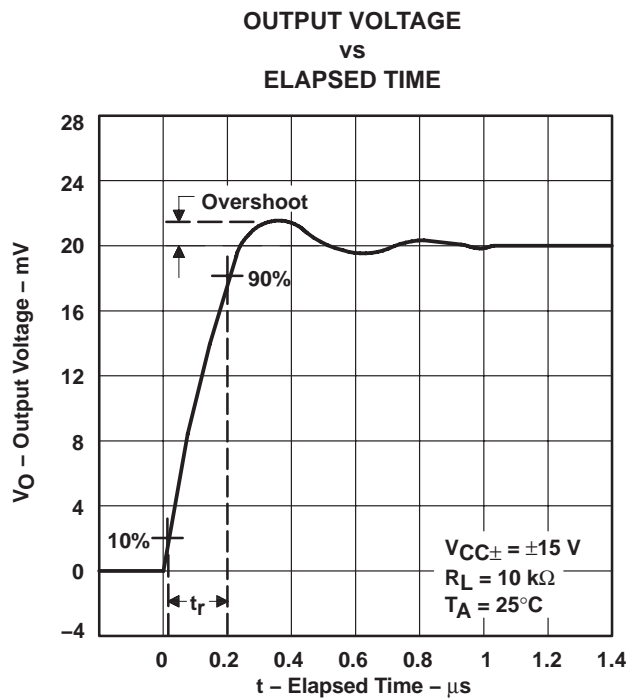


Figure 16



TYPICAL CHARACTERISTICS



**TL061, TL061A, TL061B, TL062, TL062A
TL062B, TL064, TL064A, TL064B
LOW-POWER JFET-INPUT OPERATIONAL AMPLIFIERS**

SLOAN VALLEY, CALIFORNIA SEPTEMBER 2004

APPLICATION INFORMATION

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| 0.5-Hz square-wave oscillator | TL061 | 20 |
| High-Q notch filter | TL061 | 21 |
| Audio-distribution amplifier | TL064 | 22 |
| Low-level light detector preamplifier | TL061 | 23 |
| AC amplifier | TL061 | 24 |
| Microphone preamplifier with tone control | TL061 | 25 |
| Instrumentation amplifier | TL062 | 26 |
| IC preamplifier | TL062 | 27 |

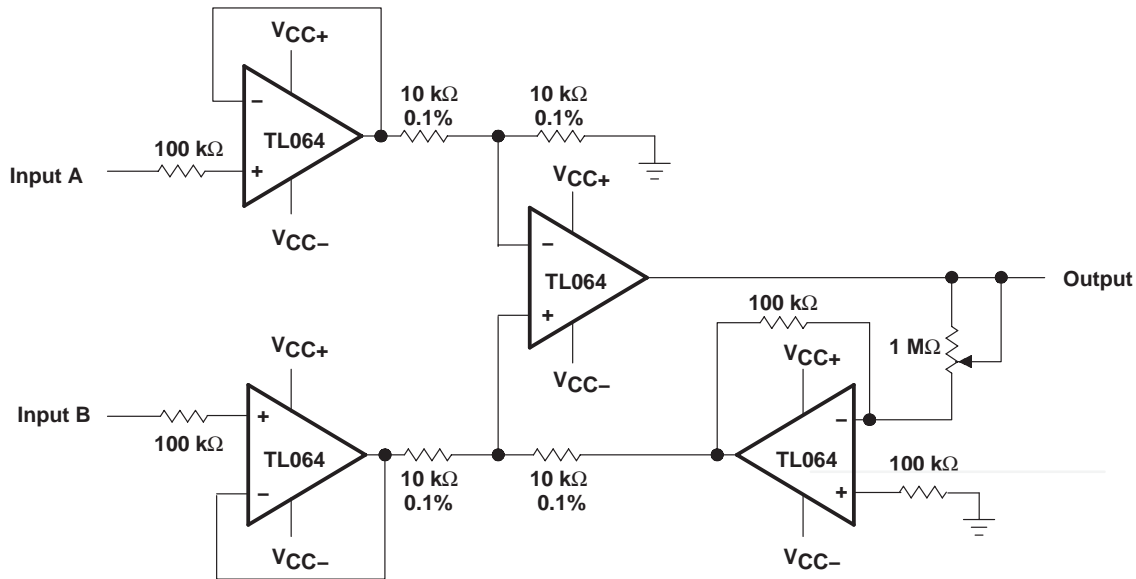


Figure 19. Instrumentation Amplifier

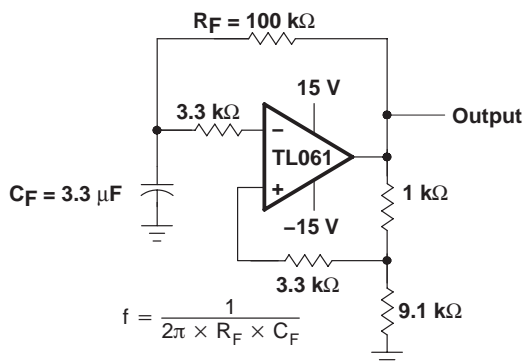


Figure 20. 0.5-Hz Square-Wave Oscillator

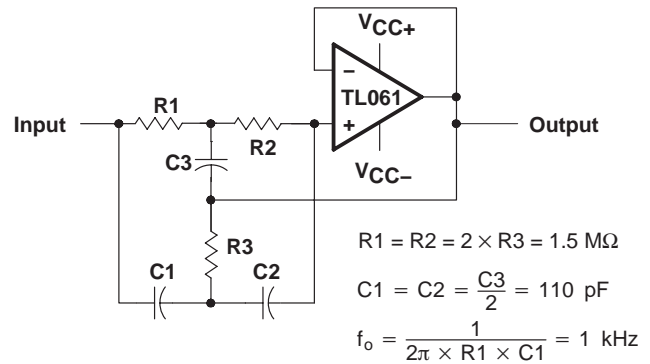


Figure 21. High-Q Notch Filter

APPLICATION INFORMATION

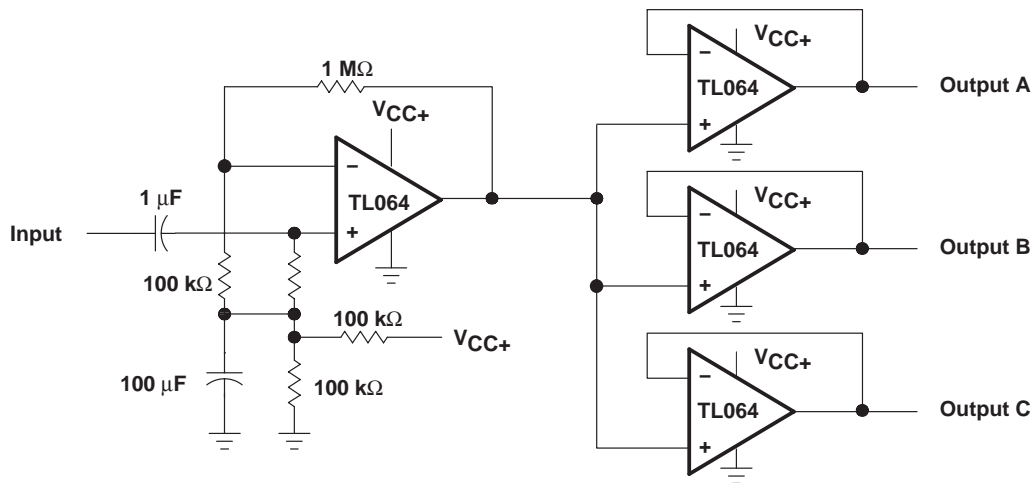


Figure 22. Audio-Distribution Amplifier

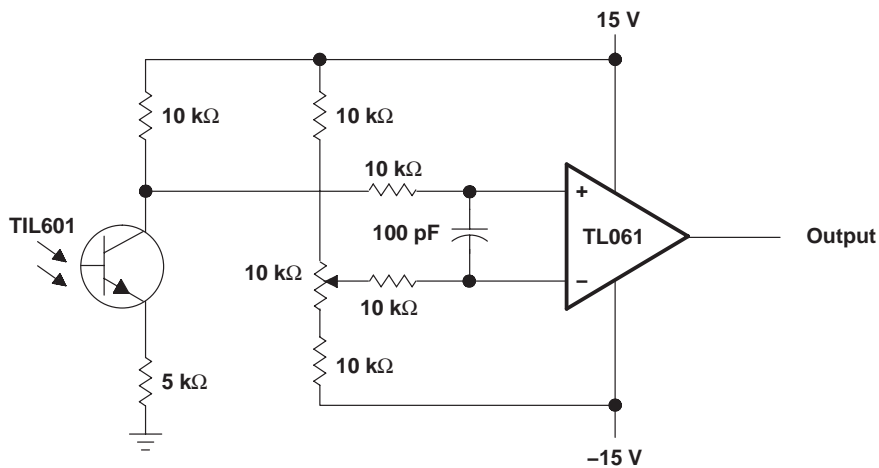


Figure 23. Low-Level Light Detector Preamplifier

**TL061, TL061A, TL061B, TL062, TL062A
TL062B, TL064, TL064A, TL064B
LOW-POWER JFET-INPUT OPERATIONAL AMPLIFIERS**

SLOS049B *REVISED* SEPTEMBER 2004

APPLICATION INFORMATION

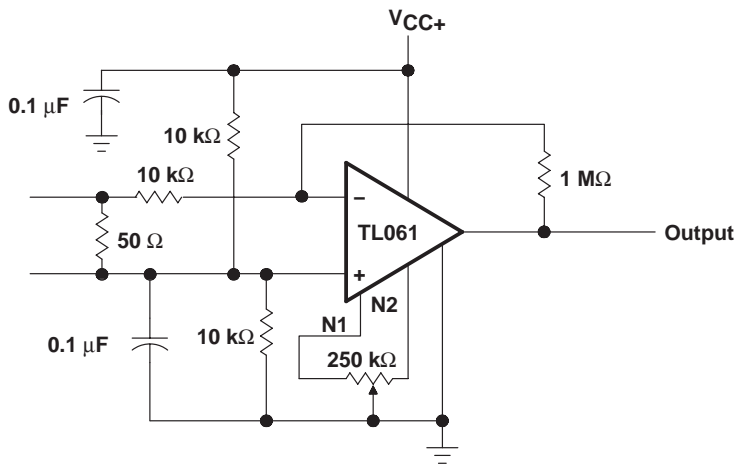


Figure 24. AC Amplifier

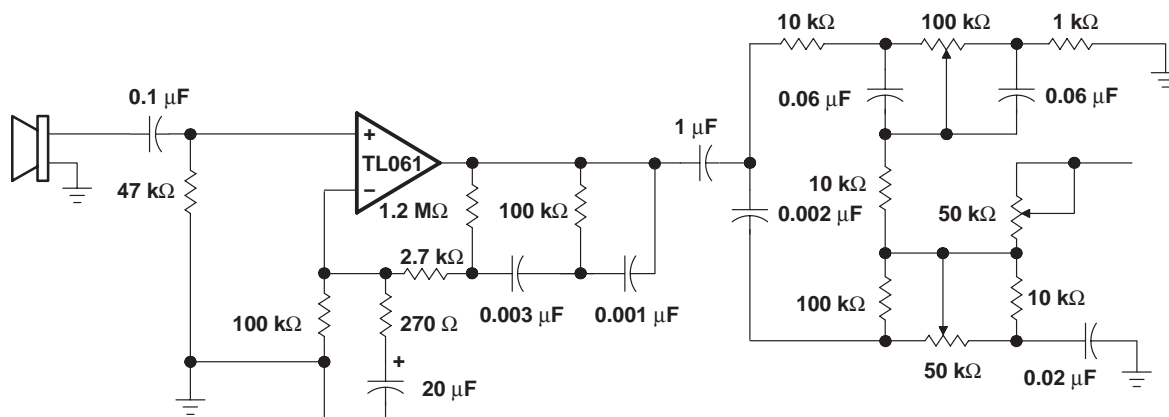


Figure 25. Microphone Preamp with Tone Control

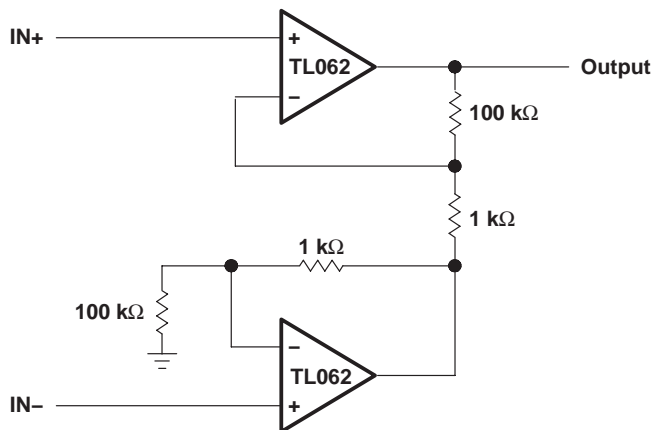


Figure 26. Instrumentation Amplifier

APPLICATION INFORMATION

IC PREAMPLIFIER RESPONSE CHARACTERISTICS

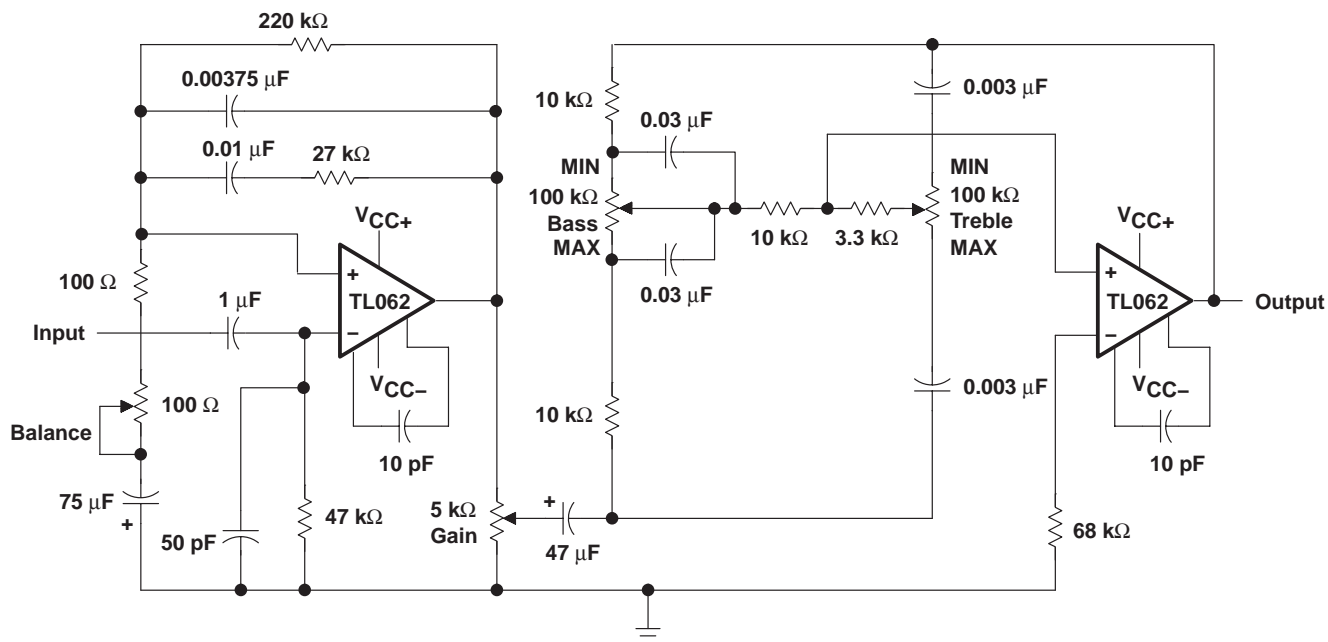
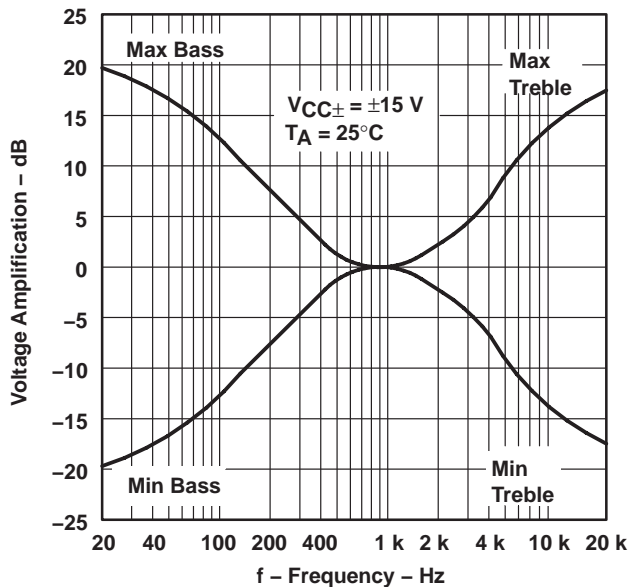


Figure 27. IC Preamplifier

PACKAGING INFORMATION

| Orderable Device | Status ⁽¹⁾ | Package Type | Package Drawing | Pins | Package Qty | Eco Plan ⁽²⁾ | Lead/Ball Finish | MSL Peak Temp ⁽³⁾ |
|------------------|-----------------------|--------------|-----------------|------|-------------|-------------------------|------------------|------------------------------|
| 81023012A | OBSOLETE | LCCC | FK | 20 | | TBD | Call TI | Call TI |
| 81023022A | ACTIVE | LCCC | FK | 20 | 1 | TBD | POST-PLATE | N / A for Pkg Type |
| 8102302HA | ACTIVE | CFP | U | 10 | 1 | TBD | A42 SNPB | N / A for Pkg Type |
| 8102302PA | ACTIVE | CDIP | JG | 8 | 1 | TBD | A42 SNPB | N / A for Pkg Type |
| 81023032A | ACTIVE | LCCC | FK | 20 | 1 | TBD | POST-PLATE | N / A for Pkg Type |
| 8102303CA | ACTIVE | CDIP | J | 14 | 1 | TBD | A42 SNPB | N / A for Pkg Type |
| 8102303DA | ACTIVE | CFP | W | 14 | 1 | TBD | A42 SNPB | N / A for Pkg Type |
| TL061ACD | ACTIVE | SOIC | D | 8 | 75 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| TL061ACDE4 | ACTIVE | SOIC | D | 8 | 75 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| TL061ACDR | ACTIVE | SOIC | D | 8 | 2500 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| TL061ACDRE4 | ACTIVE | SOIC | D | 8 | 2500 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| TL061ACP | ACTIVE | PDIP | P | 8 | 50 | Pb-Free (RoHS) | CU NIPDAU | N / A for Pkg Type |
| TL061ACPE4 | ACTIVE | PDIP | P | 8 | 50 | Pb-Free (RoHS) | CU NIPDAU | N / A for Pkg Type |
| TL061ACPSR | ACTIVE | SO | PS | 8 | 2000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| TL061ACPSRE4 | ACTIVE | SO | PS | 8 | 2000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| TL061BCD | OBSOLETE | SOIC | D | 8 | | TBD | Call TI | Call TI |
| TL061BCP | ACTIVE | PDIP | P | 8 | 50 | Pb-Free (RoHS) | CU NIPDAU | N / A for Pkg Type |
| TL061BCPE4 | ACTIVE | PDIP | P | 8 | 50 | Pb-Free (RoHS) | CU NIPDAU | N / A for Pkg Type |
| TL061CD | ACTIVE | SOIC | D | 8 | 75 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| TL061CDE4 | ACTIVE | SOIC | D | 8 | 75 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| TL061CDR | ACTIVE | SOIC | D | 8 | 2500 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| TL061CDRE4 | ACTIVE | SOIC | D | 8 | 2500 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| TL061CP | ACTIVE | PDIP | P | 8 | 50 | Pb-Free (RoHS) | CU NIPDAU | N / A for Pkg Type |
| TL061CPE4 | ACTIVE | PDIP | P | 8 | 50 | Pb-Free (RoHS) | CU NIPDAU | N / A for Pkg Type |
| TL061CPSR | ACTIVE | SO | PS | 8 | 2000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| TL061CPSRE4 | ACTIVE | SO | PS | 8 | 2000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| TL061CPWLE | OBSOLETE | TSSOP | PW | 8 | | TBD | Call TI | Call TI |
| TL061ID | ACTIVE | SOIC | D | 8 | 75 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| TL061IDE4 | ACTIVE | SOIC | D | 8 | 75 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |

| Orderable Device | Status ⁽¹⁾ | Package Type | Package Drawing | Pins | Package Qty | Eco Plan ⁽²⁾ | Lead/Ball Finish | MSL Peak Temp ⁽³⁾ |
|------------------|-----------------------|--------------|-----------------|------|-------------|-------------------------|------------------|------------------------------|
| | | | | | | no Sb/Br) | | |
| TL061IDR | ACTIVE | SOIC | D | 8 | 2500 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| TL061IDRE4 | ACTIVE | SOIC | D | 8 | 2500 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| TL061IP | ACTIVE | PDIP | P | 8 | 50 | Pb-Free (RoHS) | CU NIPDAU | N / A for Pkg Type |
| TL061IPE4 | ACTIVE | PDIP | P | 8 | 50 | Pb-Free (RoHS) | CU NIPDAU | N / A for Pkg Type |
| TL061MJG | OBSOLETE | CDIP | JG | 8 | | TBD | Call TI | Call TI |
| TL061MJGB | OBSOLETE | CDIP | JG | 8 | | TBD | Call TI | Call TI |
| TL062ACD | ACTIVE | SOIC | D | 8 | 75 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| TL062ACDE4 | ACTIVE | SOIC | D | 8 | 75 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| TL062ACDR | ACTIVE | SOIC | D | 8 | 2500 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| TL062ACDRE4 | ACTIVE | SOIC | D | 8 | 2500 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| TL062ACJG | OBSOLETE | CDIP | JG | 8 | | TBD | Call TI | Call TI |
| TL062ACP | ACTIVE | PDIP | P | 8 | 50 | Pb-Free (RoHS) | CU NIPDAU | N / A for Pkg Type |
| TL062ACPE4 | ACTIVE | PDIP | P | 8 | 50 | Pb-Free (RoHS) | CU NIPDAU | N / A for Pkg Type |
| TL062ACPSR | ACTIVE | SO | PS | 8 | 2000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| TL062ACPSRE4 | ACTIVE | SO | PS | 8 | 2000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| TL062BCD | ACTIVE | SOIC | D | 8 | 75 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| TL062BCDE4 | ACTIVE | SOIC | D | 8 | 75 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| TL062BCDR | ACTIVE | SOIC | D | 8 | 2500 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| TL062BCDRE4 | ACTIVE | SOIC | D | 8 | 2500 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| TL062BCP | ACTIVE | PDIP | P | 8 | 50 | Pb-Free (RoHS) | CU NIPDAU | N / A for Pkg Type |
| TL062BCPE4 | ACTIVE | PDIP | P | 8 | 50 | Pb-Free (RoHS) | CU NIPDAU | N / A for Pkg Type |
| TL062CD | ACTIVE | SOIC | D | 8 | 75 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| TL062CDE4 | ACTIVE | SOIC | D | 8 | 75 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| TL062CDG4 | ACTIVE | SOIC | D | 8 | 75 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| TL062CDR | ACTIVE | SOIC | D | 8 | 2500 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| TL062CDRE4 | ACTIVE | SOIC | D | 8 | 2500 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| TL062CDRG4 | ACTIVE | SOIC | D | 8 | 2500 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |

| Orderable Device | Status ⁽¹⁾ | Package Type | Package Drawing | Pins | Package Qty | Eco Plan ⁽²⁾ | Lead/Ball Finish | MSL Peak Temp ⁽³⁾ |
|------------------|-----------------------|--------------|-----------------|------|-------------|-------------------------|------------------|------------------------------|
| | | | | | | no Sb/Br) | | |
| TL062CJG | OBSOLETE | CDIP | JG | 8 | | TBD | Call TI | Call TI |
| TL062CP | ACTIVE | PDIP | P | 8 | 50 | Pb-Free (RoHS) | CU NIPDAU | N / A for Pkg Type |
| TL062CPE4 | ACTIVE | PDIP | P | 8 | 50 | Pb-Free (RoHS) | CU NIPDAU | N / A for Pkg Type |
| TL062CPSLE | OBSOLETE | SO | PS | 8 | | TBD | Call TI | Call TI |
| TL062CPSR | ACTIVE | SO | PS | 8 | 2000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| TL062CPSRE4 | ACTIVE | SO | PS | 8 | 2000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| TL062CPW | ACTIVE | TSSOP | PW | 8 | 150 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| TL062CPWE4 | ACTIVE | TSSOP | PW | 8 | 150 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| TL062CPWLE | OBSOLETE | TSSOP | PW | 8 | | TBD | Call TI | Call TI |
| TL062CPWR | ACTIVE | TSSOP | PW | 8 | 2000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| TL062CPWRE4 | ACTIVE | TSSOP | PW | 8 | 2000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| TL062CPWRG4 | ACTIVE | TSSOP | PW | 8 | 2000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| TL062ID | ACTIVE | SOIC | D | 8 | 75 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| TL062IDE4 | ACTIVE | SOIC | D | 8 | 75 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| TL062IDG4 | ACTIVE | SOIC | D | 8 | 75 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| TL062IDR | ACTIVE | SOIC | D | 8 | 2500 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| TL062IDRE4 | ACTIVE | SOIC | D | 8 | 2500 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| TL062IDRG4 | ACTIVE | SOIC | D | 8 | 2500 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| TL062IJG | OBSOLETE | CDIP | JG | 8 | | TBD | Call TI | Call TI |
| TL062IP | ACTIVE | PDIP | P | 8 | 50 | Pb-Free (RoHS) | CU NIPDAU | N / A for Pkg Type |
| TL062IPE4 | ACTIVE | PDIP | P | 8 | 50 | Pb-Free (RoHS) | CU NIPDAU | N / A for Pkg Type |
| TL062IPWR | ACTIVE | TSSOP | PW | 8 | 2000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| TL062IPWRE4 | ACTIVE | TSSOP | PW | 8 | 2000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| TL062MFKB | ACTIVE | LCCC | FK | 20 | 1 | TBD | POST-PLATE | N / A for Pkg Type |
| TL062MJG | ACTIVE | CDIP | JG | 8 | 1 | TBD | A42 SNPB | N / A for Pkg Type |
| TL062MJGB | ACTIVE | CDIP | JG | 8 | 1 | TBD | A42 SNPB | N / A for Pkg Type |
| TL064ACD | ACTIVE | SOIC | D | 14 | 50 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| TL064ACDE4 | ACTIVE | SOIC | D | 14 | 50 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |

| Orderable Device | Status ⁽¹⁾ | Package Type | Package Drawing | Pins | Package Qty | Eco Plan ⁽²⁾ | Lead/Ball Finish | MSL Peak Temp ⁽³⁾ |
|------------------|-----------------------|--------------|-----------------|------|-------------|-------------------------|------------------|------------------------------|
| TL064ACDR | ACTIVE | SOIC | D | 14 | 2500 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| TL064ACDRE4 | ACTIVE | SOIC | D | 14 | 2500 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| TL064ACN | ACTIVE | PDIP | N | 14 | 25 | Pb-Free (RoHS) | CU NIPDAU | N / A for Pkg Type |
| TL064ACNE4 | ACTIVE | PDIP | N | 14 | 25 | Pb-Free (RoHS) | CU NIPDAU | N / A for Pkg Type |
| TL064BCD | ACTIVE | SOIC | D | 14 | 50 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| TL064BCDE4 | ACTIVE | SOIC | D | 14 | 50 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| TL064BCDR | ACTIVE | SOIC | D | 14 | 2500 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| TL064BCDRE4 | ACTIVE | SOIC | D | 14 | 2500 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| TL064BCN | ACTIVE | PDIP | N | 14 | 25 | Pb-Free (RoHS) | CU NIPDAU | N / A for Pkg Type |
| TL064BCNE4 | ACTIVE | PDIP | N | 14 | 25 | Pb-Free (RoHS) | CU NIPDAU | N / A for Pkg Type |
| TL064CD | ACTIVE | SOIC | D | 14 | 50 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| TL064CDBR | ACTIVE | SSOP | DB | 14 | 2000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| TL064CDBRE4 | ACTIVE | SSOP | DB | 14 | 2000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| TL064CDE4 | ACTIVE | SOIC | D | 14 | 50 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| TL064CDR | ACTIVE | SOIC | D | 14 | 2500 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| TL064CDRE4 | ACTIVE | SOIC | D | 14 | 2500 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| TL064CN | ACTIVE | PDIP | N | 14 | 25 | Pb-Free (RoHS) | CU NIPDAU | N / A for Pkg Type |
| TL064CNE4 | ACTIVE | PDIP | N | 14 | 25 | Pb-Free (RoHS) | CU NIPDAU | N / A for Pkg Type |
| TL064CNSR | ACTIVE | SO | NS | 14 | 2000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| TL064CNSRE4 | ACTIVE | SO | NS | 14 | 2000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| TL064CPW | ACTIVE | TSSOP | PW | 14 | 90 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| TL064CPWE4 | ACTIVE | TSSOP | PW | 14 | 90 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| TL064CPWLE | OBSOLETE | TSSOP | PW | 14 | | TBD | Call TI | Call TI |
| TL064CPWR | ACTIVE | TSSOP | PW | 14 | 2000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| TL064CPWRE4 | ACTIVE | TSSOP | PW | 14 | 2000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| TL064ID | ACTIVE | SOIC | D | 14 | 50 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |

| Orderable Device | Status ⁽¹⁾ | Package Type | Package Drawing | Pins | Package Qty | Eco Plan ⁽²⁾ | Lead/Ball Finish | MSL Peak Temp ⁽³⁾ |
|------------------|-----------------------|--------------|-----------------|------|-------------|-------------------------|------------------|------------------------------|
| TL064IDE4 | ACTIVE | SOIC | D | 14 | 50 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| TL064IDG4 | ACTIVE | SOIC | D | 14 | 50 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| TL064IDR | ACTIVE | SOIC | D | 14 | 2500 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| TL064IDRE4 | ACTIVE | SOIC | D | 14 | 2500 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| TL064IDRG4 | ACTIVE | SOIC | D | 14 | 2500 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| TL064IN | ACTIVE | PDIP | N | 14 | 25 | Pb-Free (RoHS) | CU NIPDAU | N / A for Pkg Type |
| TL064INE4 | ACTIVE | PDIP | N | 14 | 25 | Pb-Free (RoHS) | CU NIPDAU | N / A for Pkg Type |
| TL064INS | ACTIVE | SO | NS | 14 | 50 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| TL064INSG4 | ACTIVE | SO | NS | 14 | 50 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| TL064INSR | ACTIVE | SO | NS | 14 | 2000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| TL064INSRG4 | ACTIVE | SO | NS | 14 | 2000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| TL064MFK | ACTIVE | LCCC | FK | 20 | 1 | TBD | POST-PLATE | N / A for Pkg Type |
| TL064MFKB | ACTIVE | LCCC | FK | 20 | 1 | TBD | POST-PLATE | N / A for Pkg Type |
| TL064MJ | ACTIVE | CDIP | J | 14 | 1 | TBD | A42 SNPB | N / A for Pkg Type |
| TL064MJB | ACTIVE | CDIP | J | 14 | 1 | TBD | A42 SNPB | N / A for Pkg Type |
| TL064MWB | ACTIVE | CFP | W | 14 | 1 | TBD | A42 SNPB | N / A for Pkg Type |

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

⁽²⁾ Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

⁽³⁾ MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

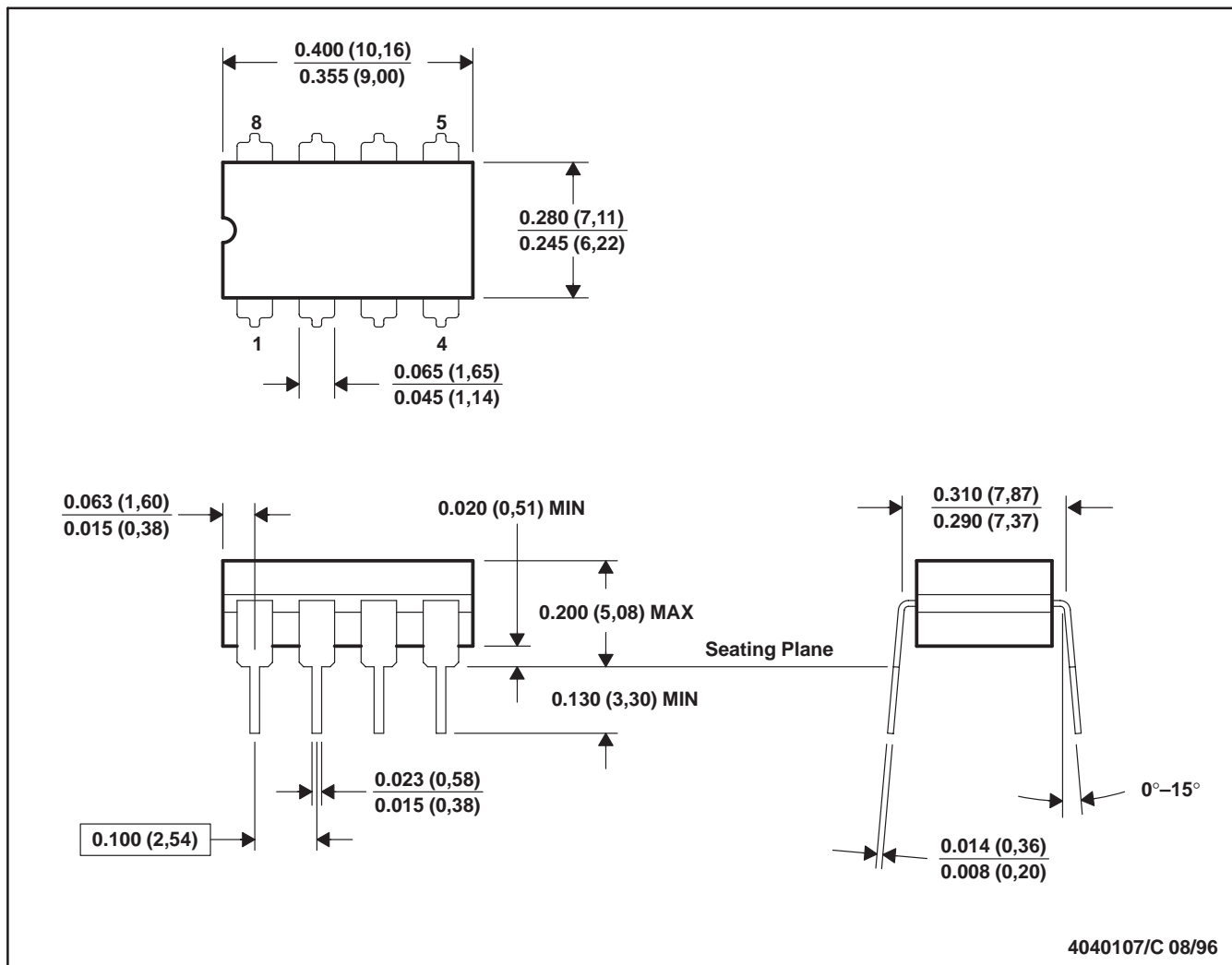
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JG (R-GDIP-T8)

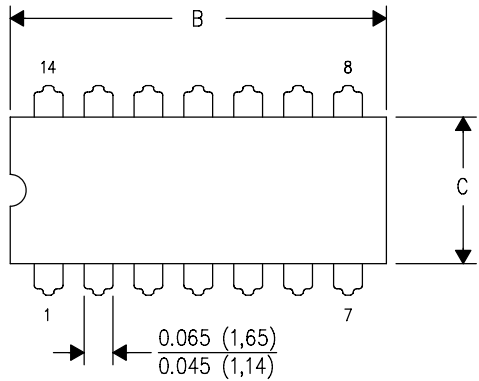
CERAMIC DUAL-IN-LINE



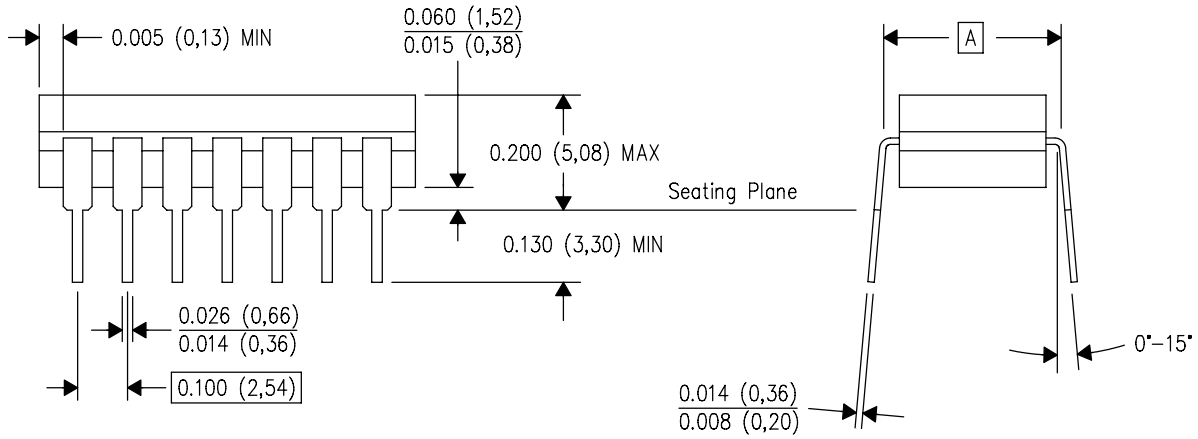
- NOTES: A. All linear dimensions are in inches (millimeters).
 B. This drawing is subject to change without notice.
 C. This package can be hermetically sealed with a ceramic lid using glass frit.
 D. Index point is provided on cap for terminal identification.
 E. Falls within MIL STD 1835 GDIP1-T8

J (R-GDIP-T**)
 14 LEADS SHOWN

CERAMIC DUAL IN-LINE PACKAGE



| DIM \ PINS ** | 14 | 16 | 18 | 20 |
|---------------|------------------------|------------------------|------------------------|------------------------|
| A | 0.300 (7,62) BSC | 0.300 (7,62) BSC | 0.300 (7,62) BSC | 0.300 (7,62) BSC |
| B MAX | 0.785 (19,94) | .840 (21,34) | 0.960 (24,38) | 1.060 (26,92) |
| B MIN | — | — | — | — |
| C MAX | 0.300 (7,62) | 0.300 (7,62) | 0.310 (7,87) | 0.300 (7,62) |
| C MIN | 0.245 (6,22) | 0.245 (6,22) | 0.220 (5,59) | 0.245 (6,22) |

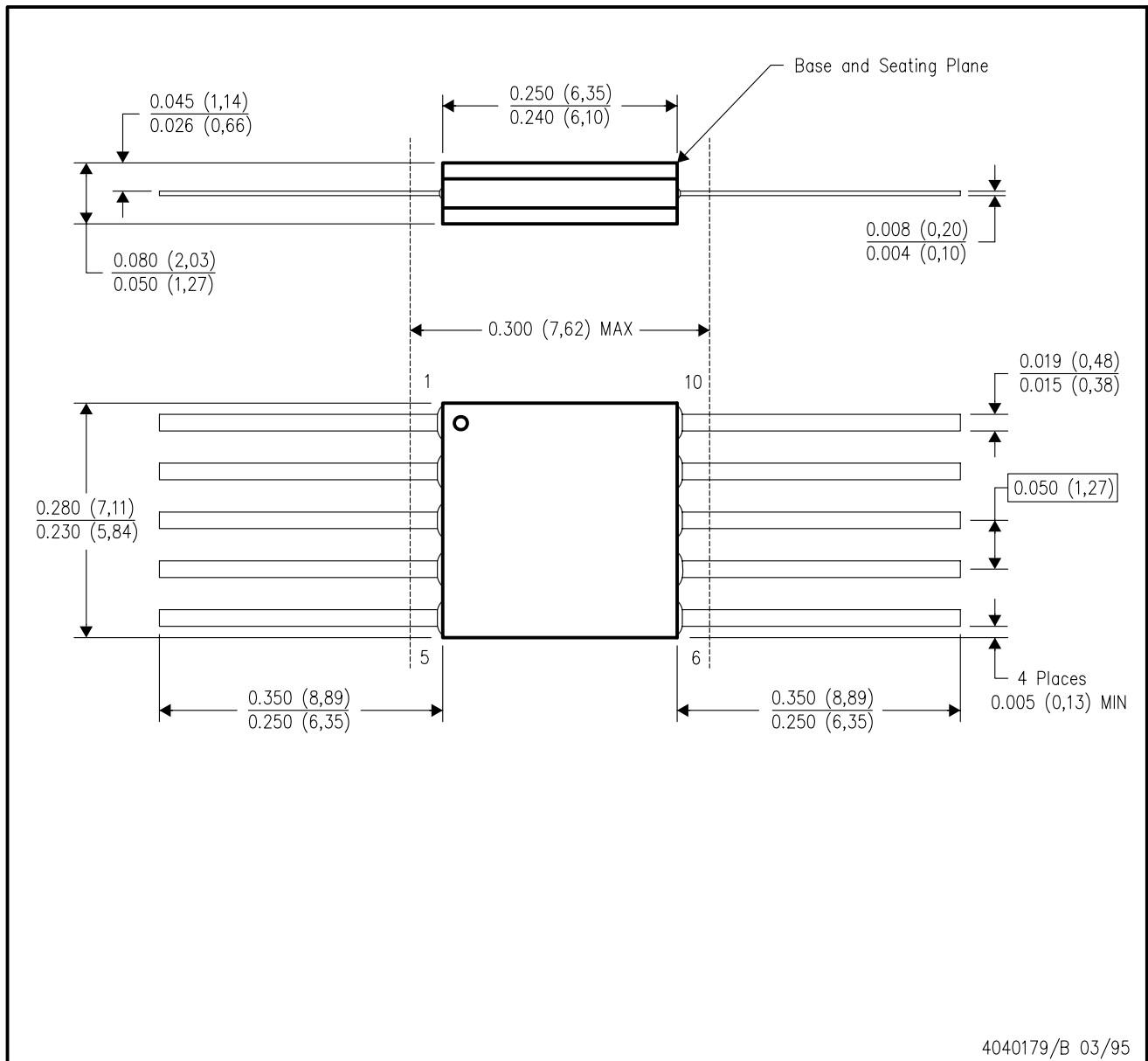


4040083/F 03/03

- NOTES:
- A. All linear dimensions are in inches (millimeters).
 - B. This drawing is subject to change without notice.
 - C. This package is hermetically sealed with a ceramic lid using glass frit.
 - D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
 - E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

U (S-GDFP-F10)

CERAMIC DUAL FLATPACK

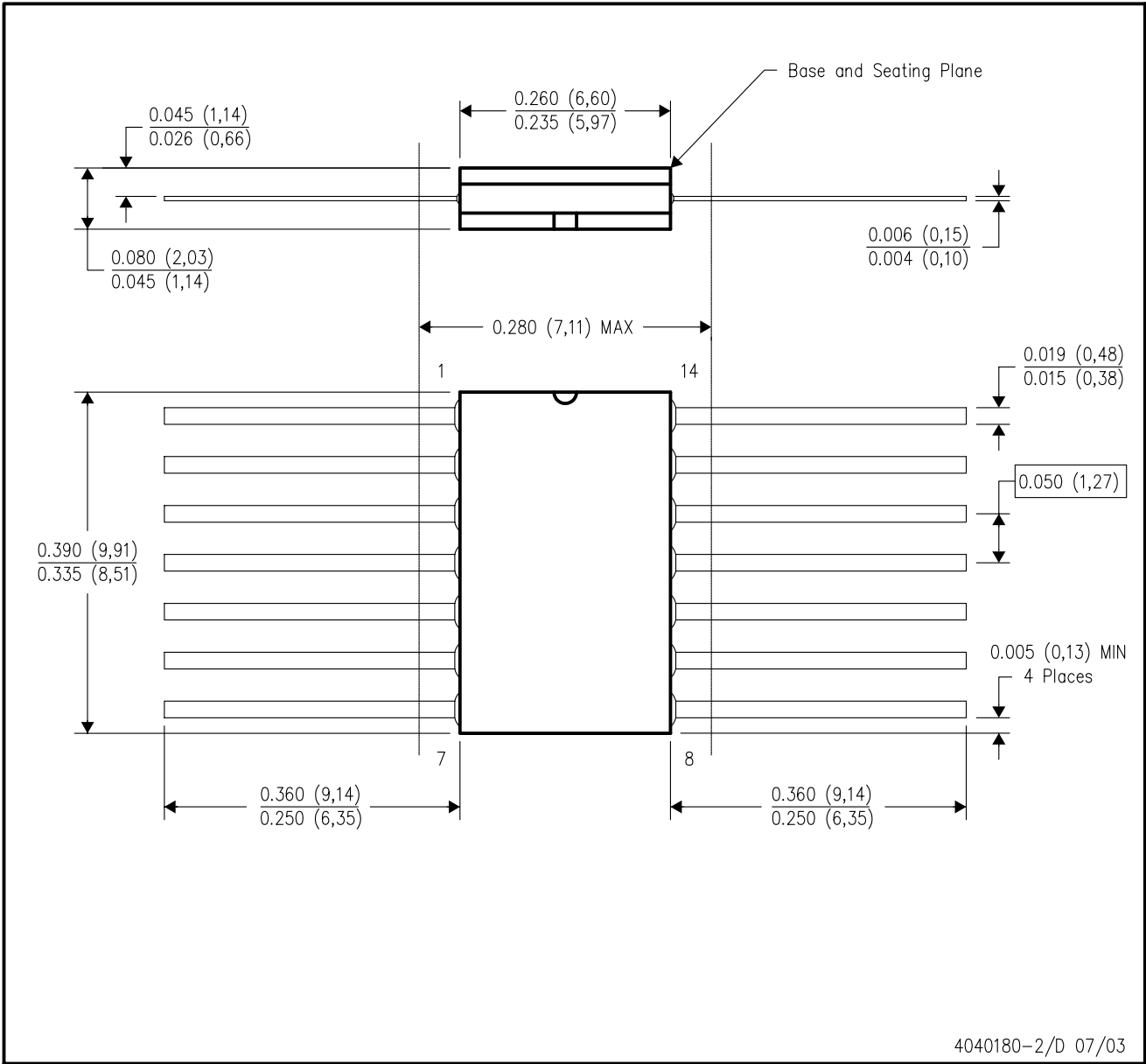


- NOTES:
- All linear dimensions are in inches (millimeters).
 - This drawing is subject to change without notice.
 - This package can be hermetically sealed with a ceramic lid using glass frit.
 - Index point is provided on cap for terminal identification only.
 - Falls within MIL STD 1835 GDFP1-F10 and JEDEC MO-092AA

[查询"81023012A"供应商](#)

W (R-GDFP-F14)

CERAMIC DUAL FLATPACK

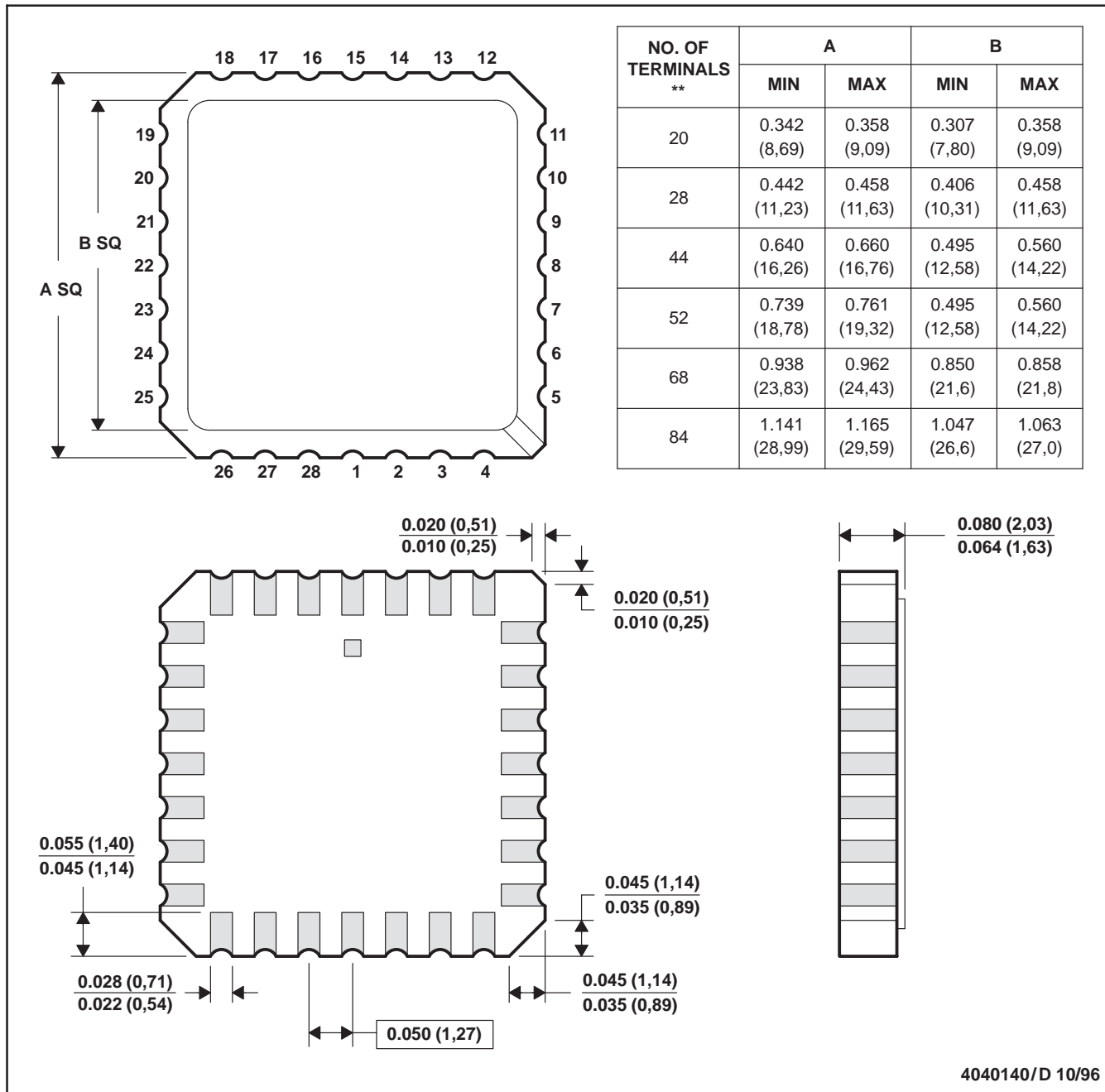


- NOTES:
- A. All linear dimensions are in inches (millimeters).
 - B. This drawing is subject to change without notice.
 - C. This package can be hermetically sealed with a ceramic lid using glass frit.
 - D. Index point is provided on cap for terminal identification only.
 - E. Falls within MIL STD 1835 GDFP1-F14 and JEDEC MO-092AB

FK (S-CQCC-N**)

LEADLESS CERAMIC CHIP CARRIER

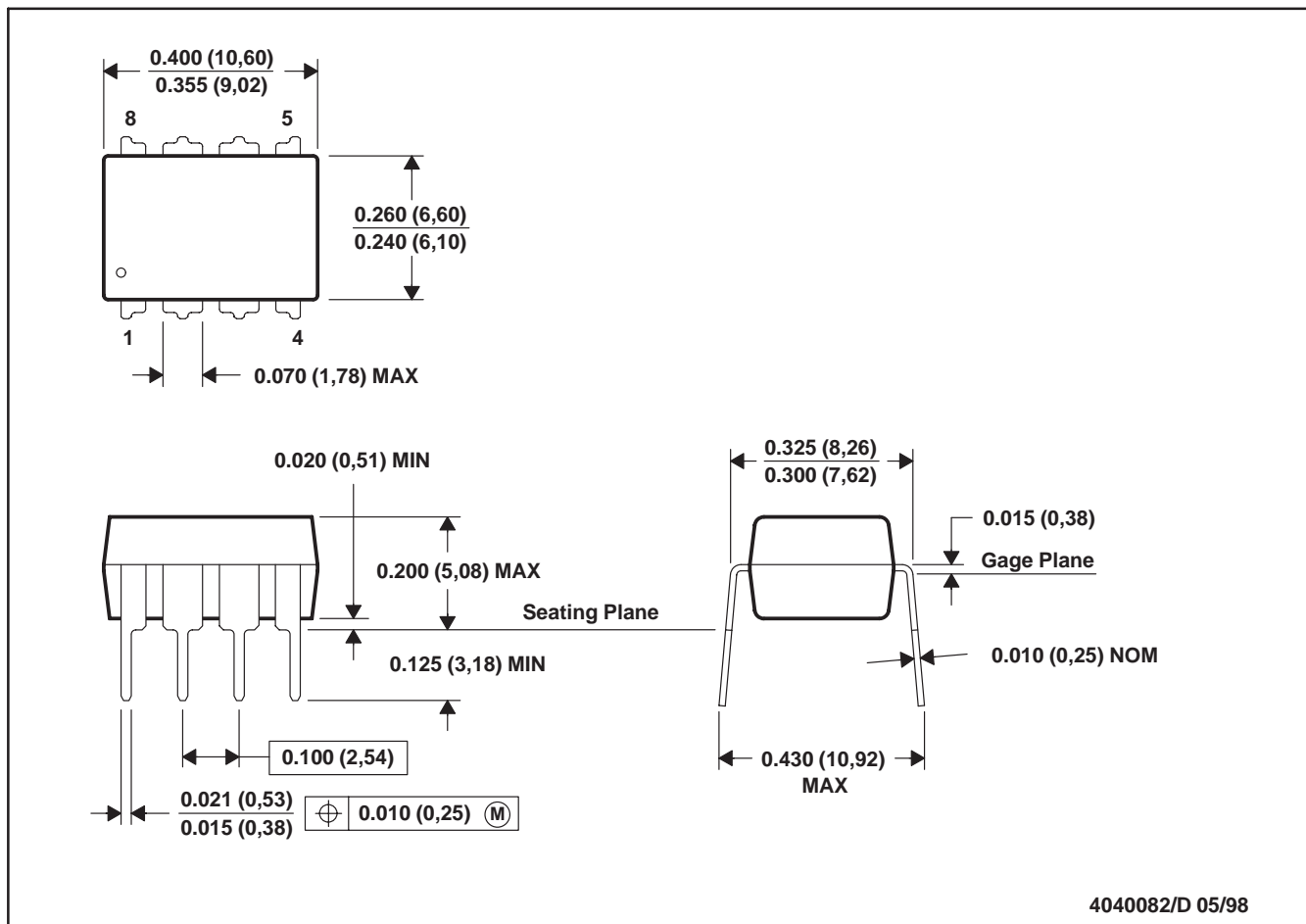
28 TERMINAL SHOWN



- NOTES: A. All linear dimensions are in inches (millimeters).
 B. This drawing is subject to change without notice.
 C. This package can be hermetically sealed with a metal lid.
 D. The terminals are gold plated.
 E. Falls within JEDEC MS-004

P (R-PDIP-T8)

PLASTIC DUAL-IN-LINE



- NOTES: A. All linear dimensions are in inches (millimeters).
 B. This drawing is subject to change without notice.
 C. Falls within JEDEC MS-001

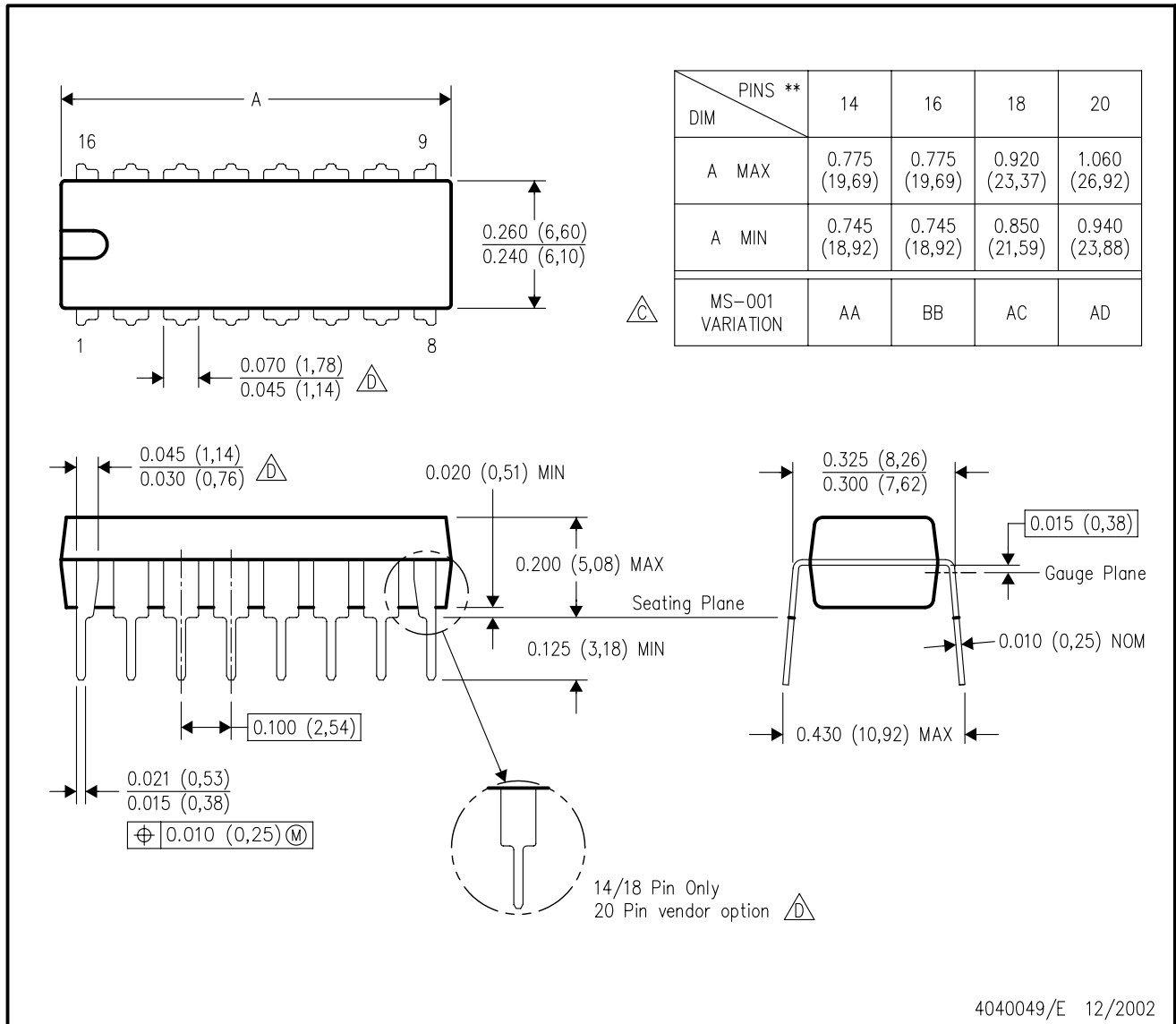
For the latest package information, go to http://www.ti.com/sc/docs/package/pkg_info.htm

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N (R-PDIP-T**)

PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN

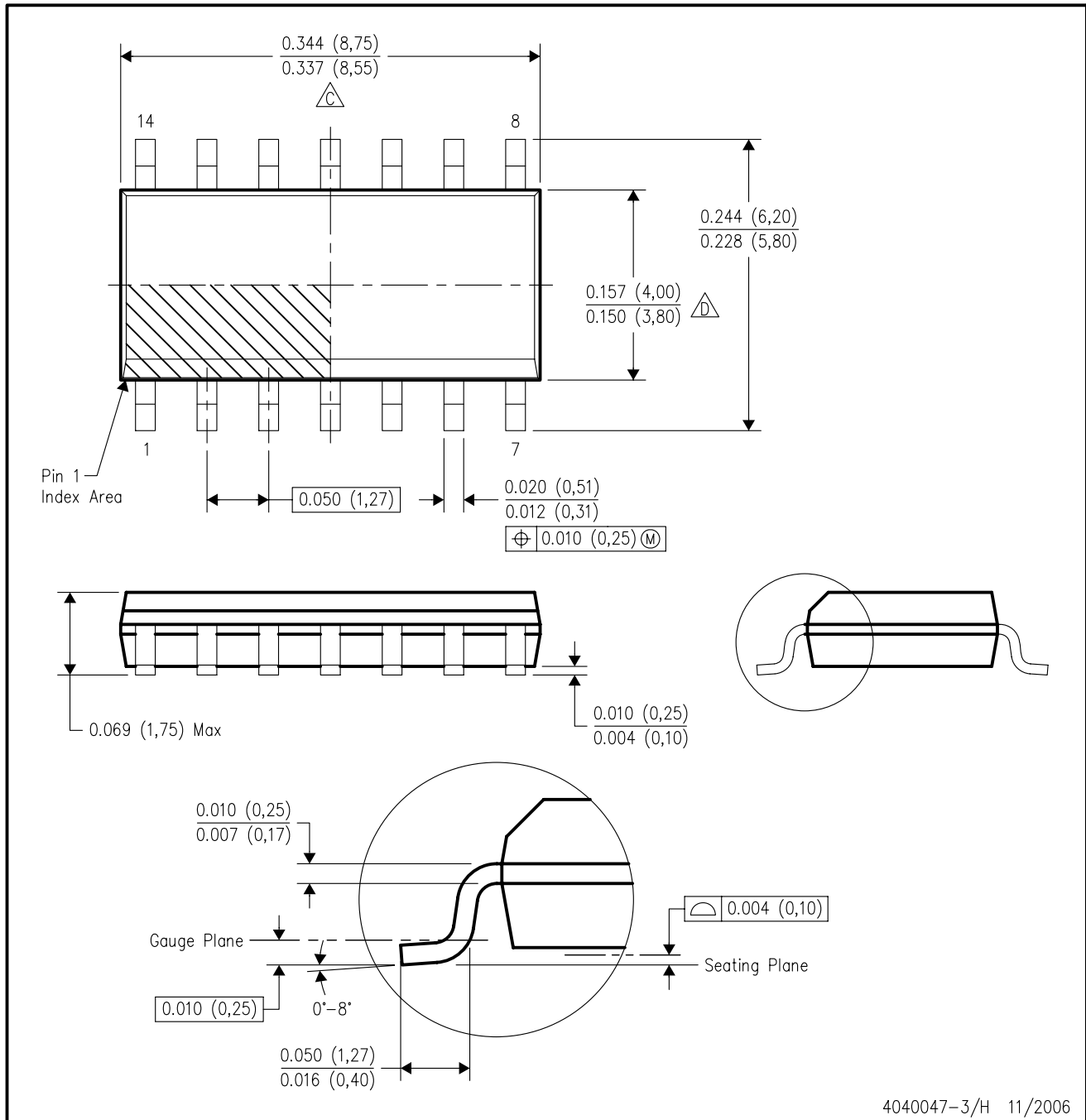


- NOTES:
- A. All linear dimensions are in inches (millimeters).
 - B. This drawing is subject to change without notice.
 - Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
 - The 20 pin end lead shoulder width is a vendor option, either half or full width.

[查询"81023012A"供应商](#)

D (R-PDSO-G14)

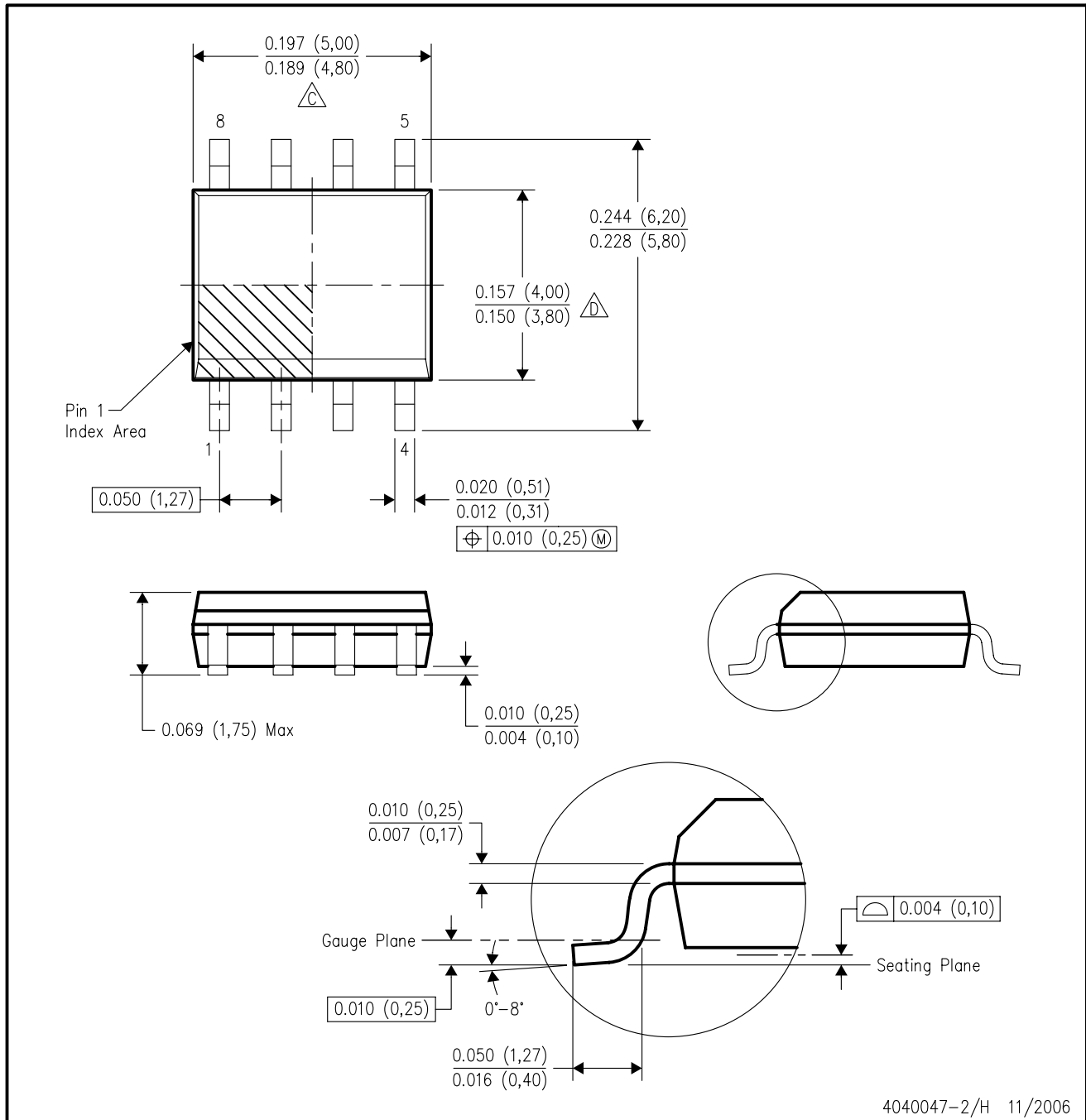
PLASTIC SMALL-OUTLINE PACKAGE



- NOTES:
- A. All linear dimensions are in inches (millimeters).
 - B. This drawing is subject to change without notice.
 - C. Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed .006 (0,15) per end.
 - D. Body width does not include interlead flash. Interlead flash shall not exceed .017 (0,43) per side.
 - E. Reference JEDEC MS-012 variation AB.

D (R-PDSO-G8)

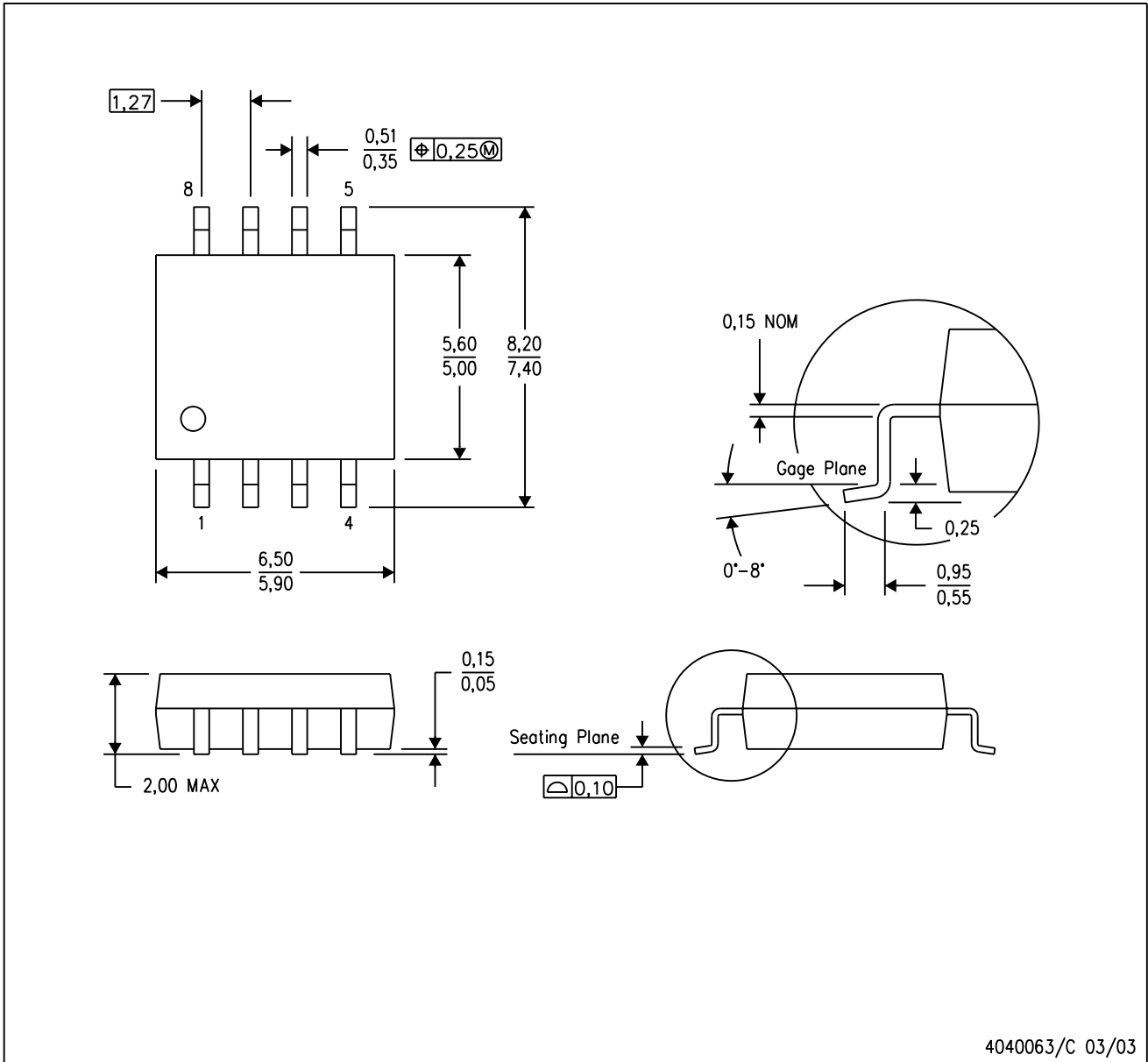
PLASTIC SMALL-OUTLINE PACKAGE



MECHANICAL DATA

PS (R-PDSO-G8)

PLASTIC SMALL-OUTLINE PACKAGE



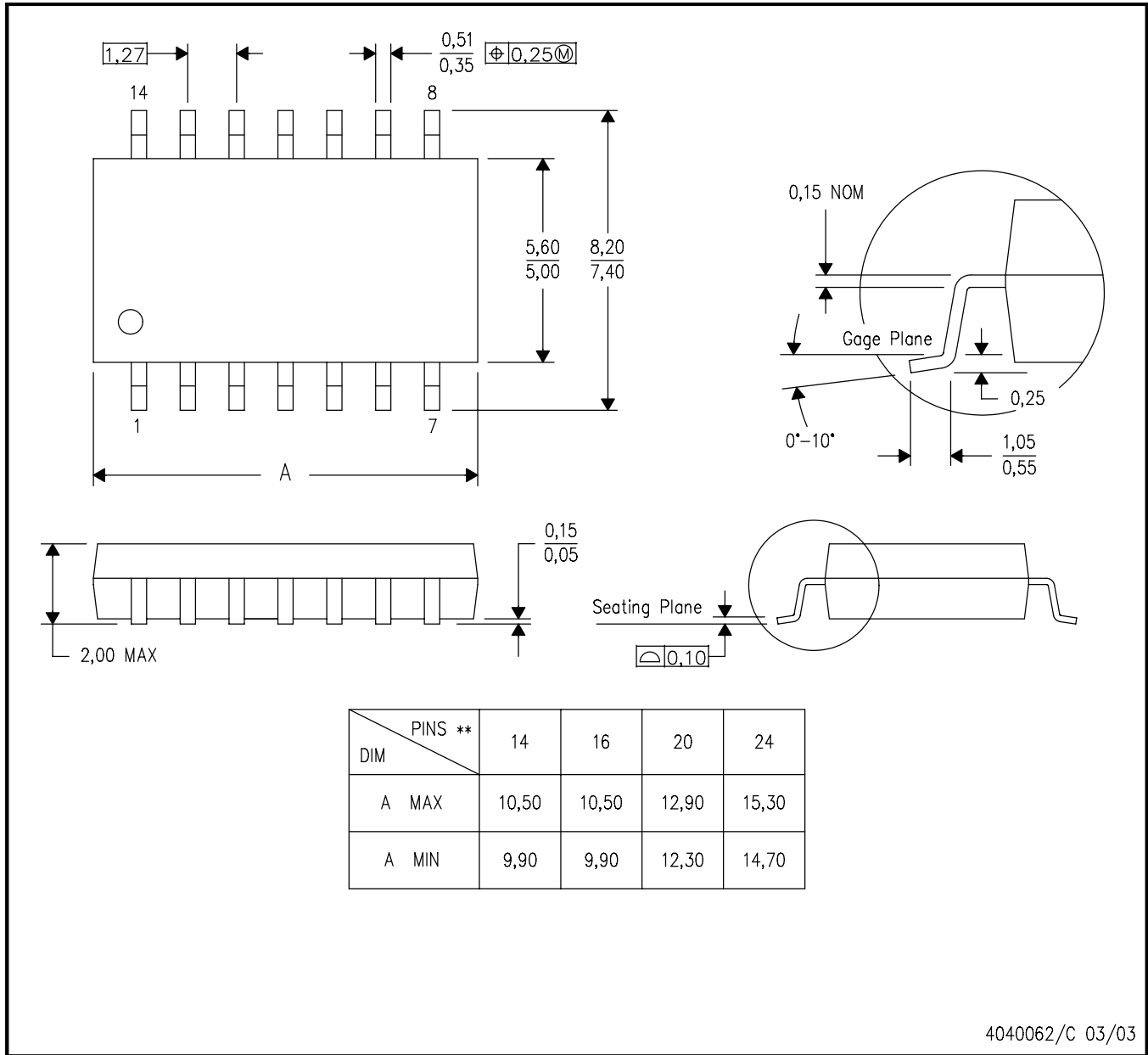
- NOTES:
- A. All linear dimensions are in millimeters.
 - B. This drawing is subject to change without notice.
 - C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.

MECHANICAL DATA

NS (R-PDSO-G**)

PLASTIC SMALL-OUTLINE PACKAGE

14-PINS SHOWN

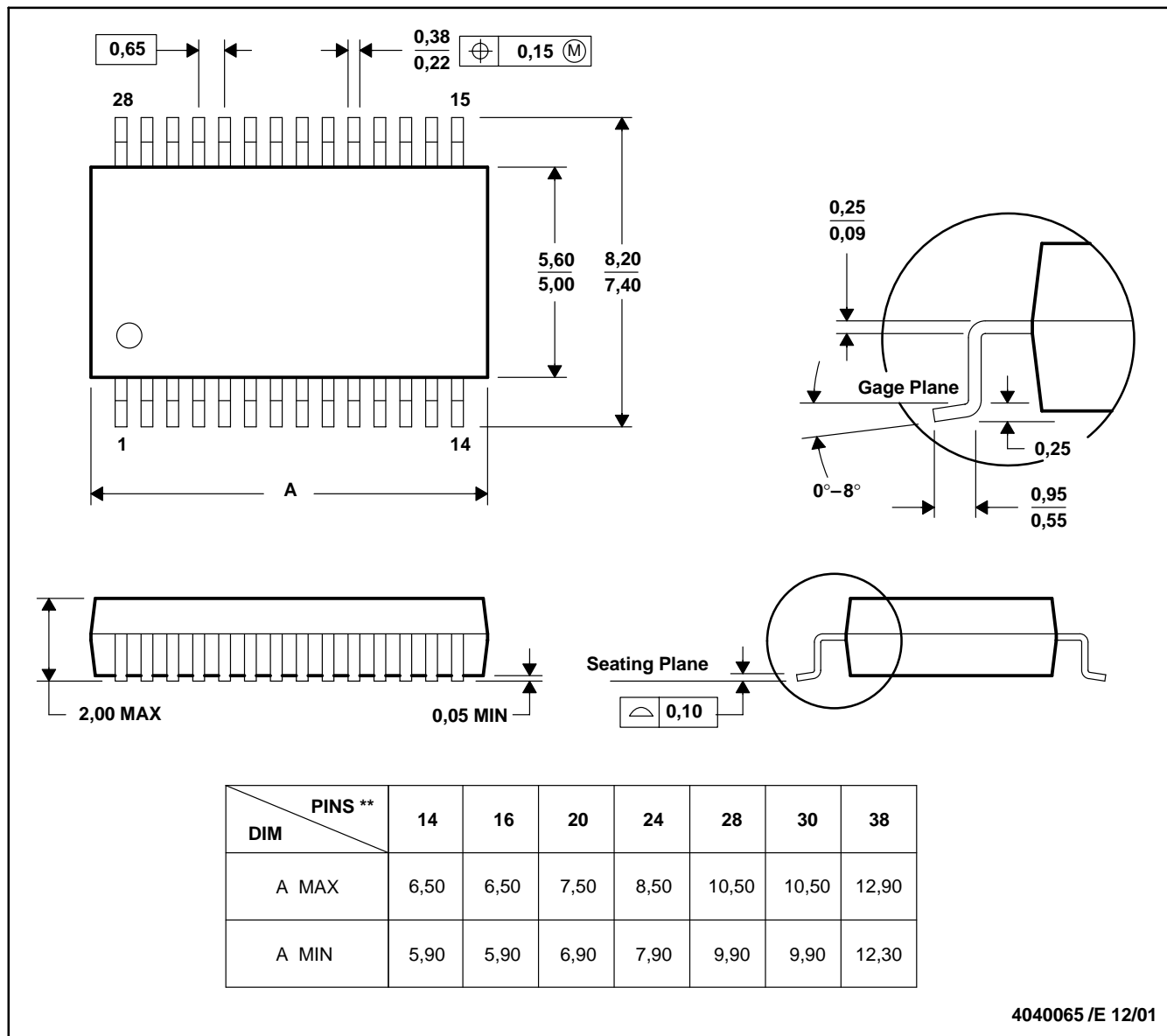


- NOTES:
- A. All linear dimensions are in millimeters.
 - B. This drawing is subject to change without notice.
 - C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.

DB (R-PDSO-G**)

PLASTIC SMALL-OUTLINE

28 PINS SHOWN

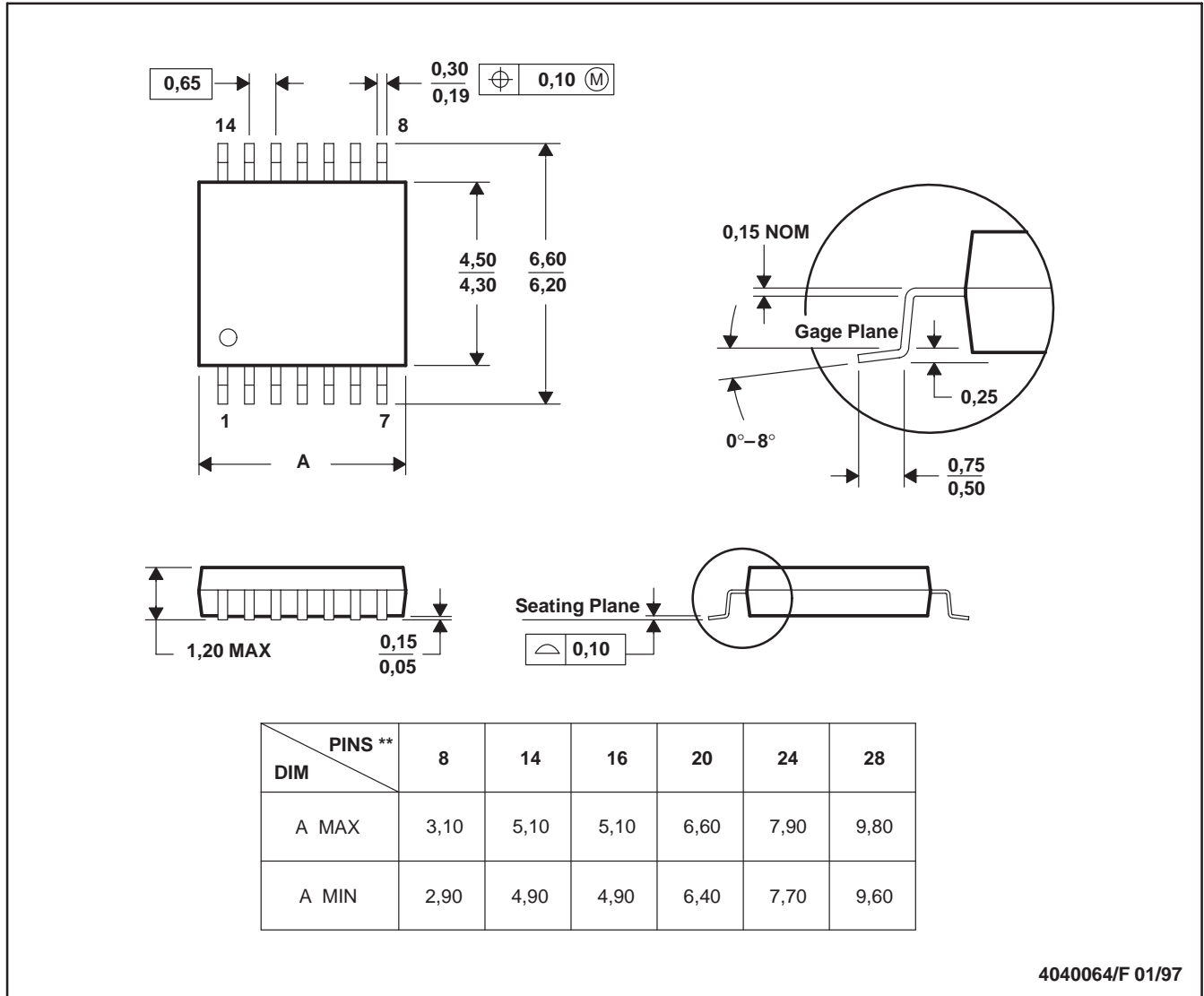


- NOTES: A. All linear dimensions are in millimeters.
 B. This drawing is subject to change without notice.
 C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.
 D. Falls within JEDEC MO-150

PW (R-PDSO-G**)

PLASTIC SMALL-OUTLINE PACKAGE

14 PINS SHOWN



4040064/F 01/97

- NOTES: A. All linear dimensions are in millimeters.
 B. This drawing is subject to change without notice.
 C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.
 D. Falls within JEDEC MO-153

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